


Nanoscale Chemical Analysis and Mapping for ALD Process Development and Control

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Complements other standard analytical techniques

	IR PiFM	Raman	FTIR	TOF-SIMS	XPS	TXRF	SEM/EDS	TEM	Auger
Species Detected	M.I.	M.I.	M.I.	M.I.	M.I.	E.I.	E.I.	E.I.	E.I.
Chemical Mapping	Yes	Yes	Yes	Yes	Yes	Yes (Elemental)	Yes (Elemental)	Yes (Elemental)	Yes (Elemental)
Lateral Resolution	< 5 nm ~ 20 nm ⁺	> 0.5 μm	> 10 μm	> 0.2 μm	10 μm – 2 mm	~ 1 mm	1 nm* 0.5 μm EDS	0.2 nm* 1 ~ 20 nm EDS	~ 10 nm
Depth Probed	< 20 nm ~ 500 nm ⁺	> 500 nm	1 μm	1 nm	10 nm	10 nm	1 μm	~ 100 nm	10 nm

+ bulk mode

* imaging

M.I. molecular information

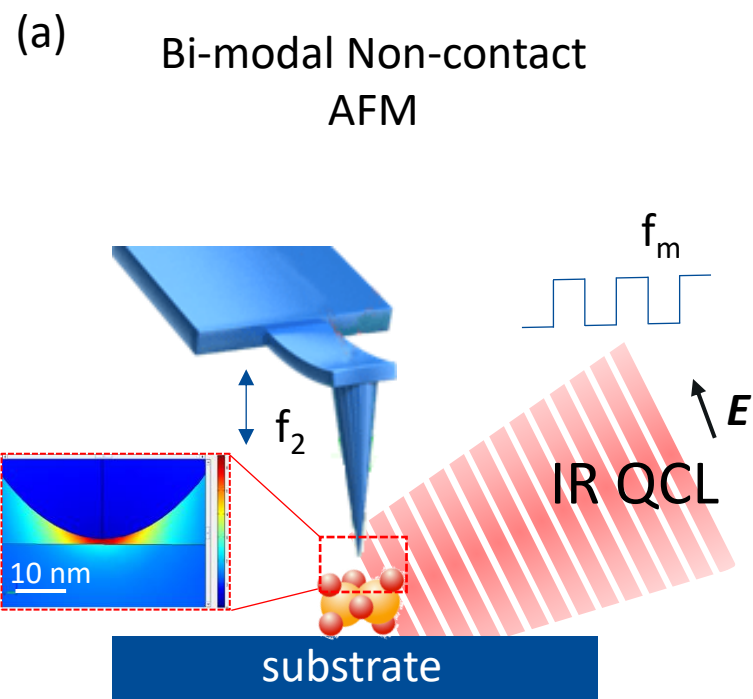
E.I. elemental information

Color coded for semiconductor applications with small dimensions.

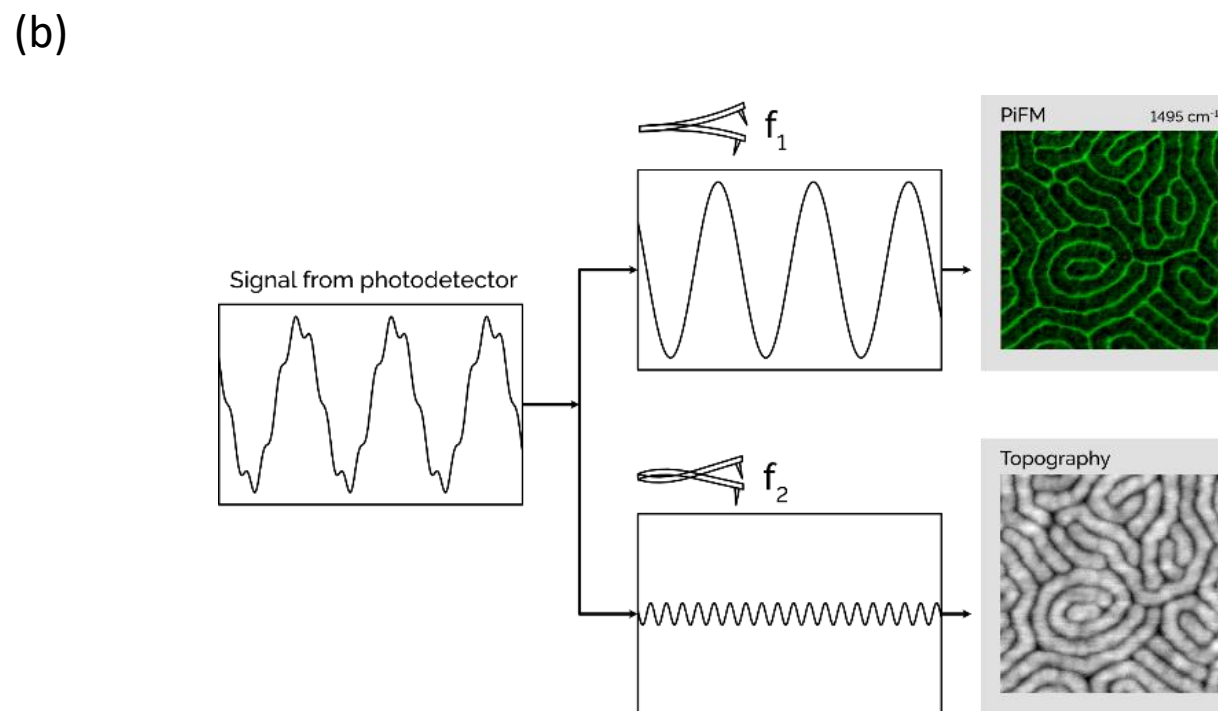
IR PiFM brings molecular analysis to the realm of true nanoscale, providing both IR absorption spectra and chemical mapping with ~ 5 nm spatial resolution and monolayer sensitivity.



Infrared Photo-induced force microscope (IR PiFM)



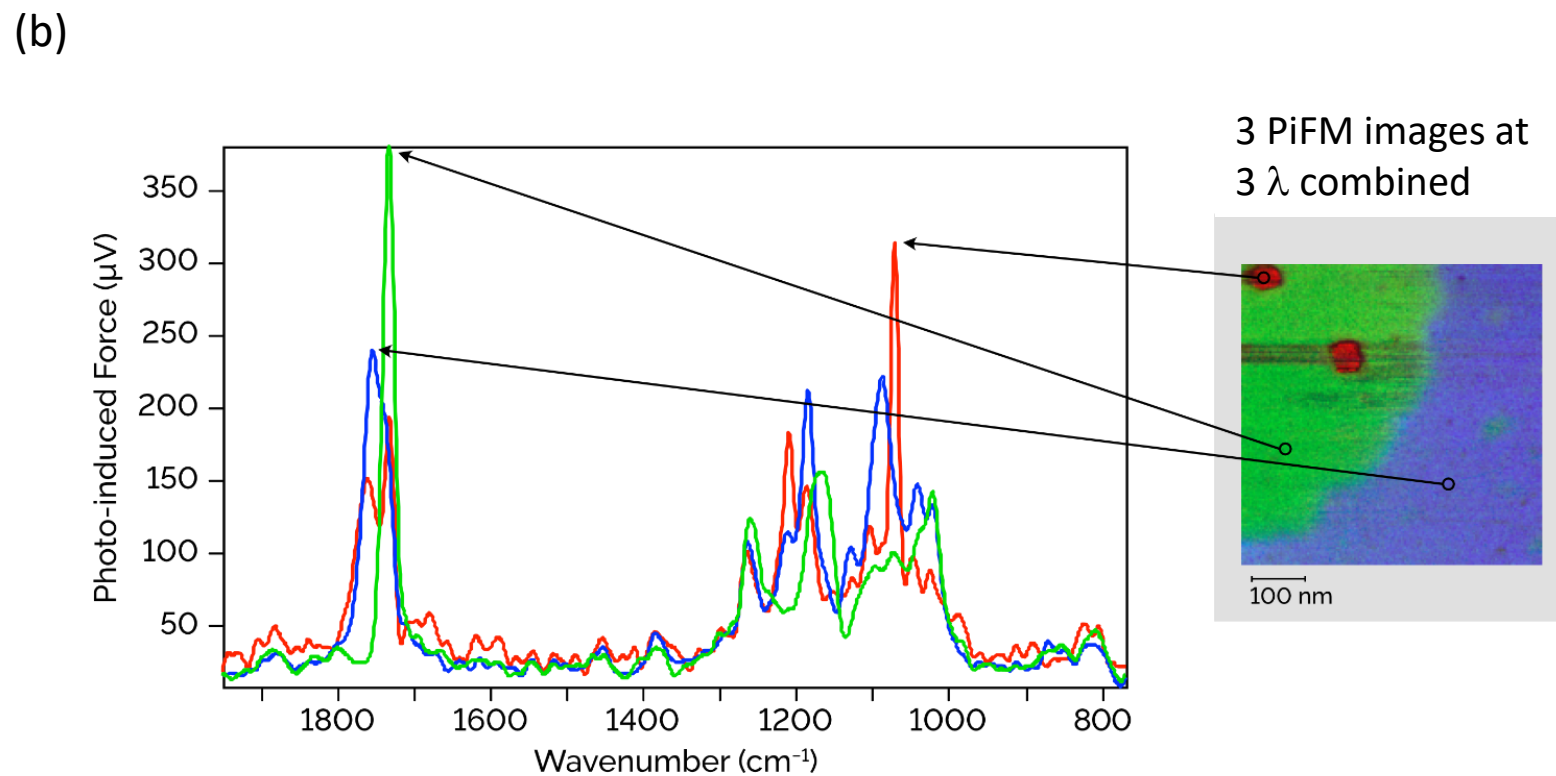
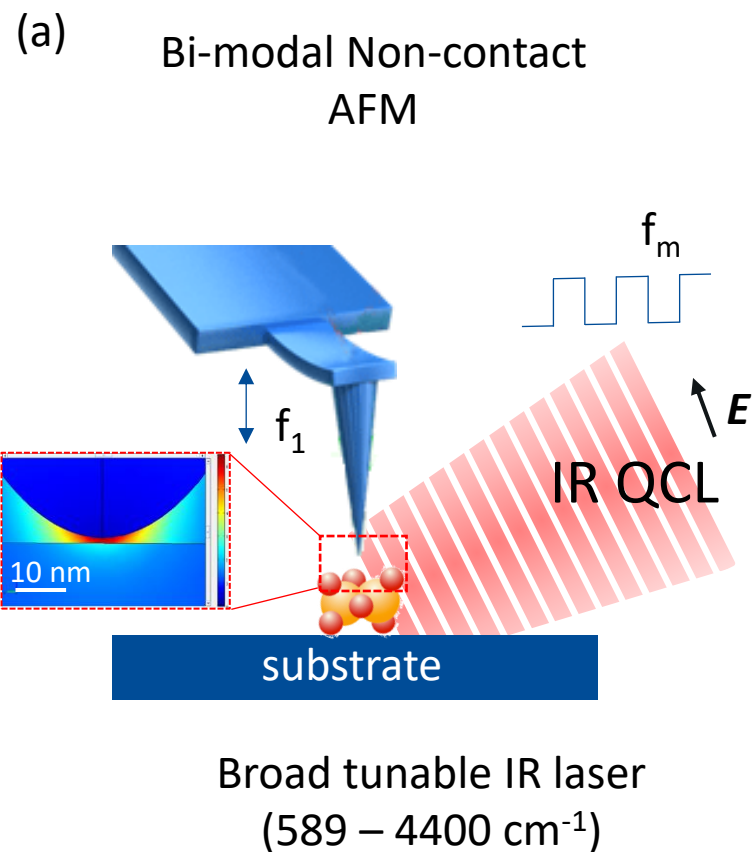
Broad tunable IR laser
(589 – 4400 cm^{-1})



A multi-modal AFM approach can collect PiFM chemical maps and topography images simultaneously.

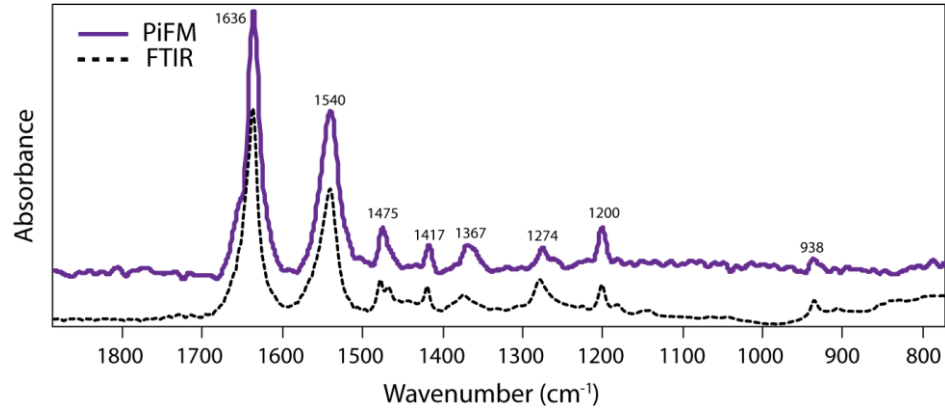


Infrared Photo-induced force microscope (IR PiFM)

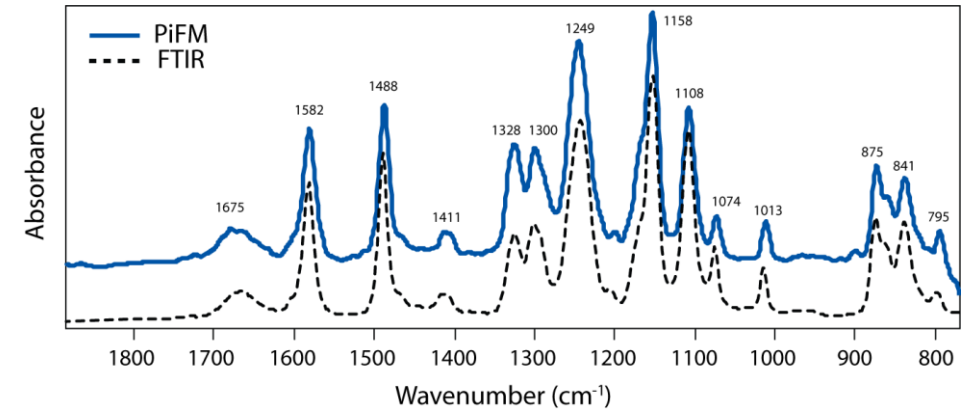


Good agreement between PiF-IR and FTIR spectra

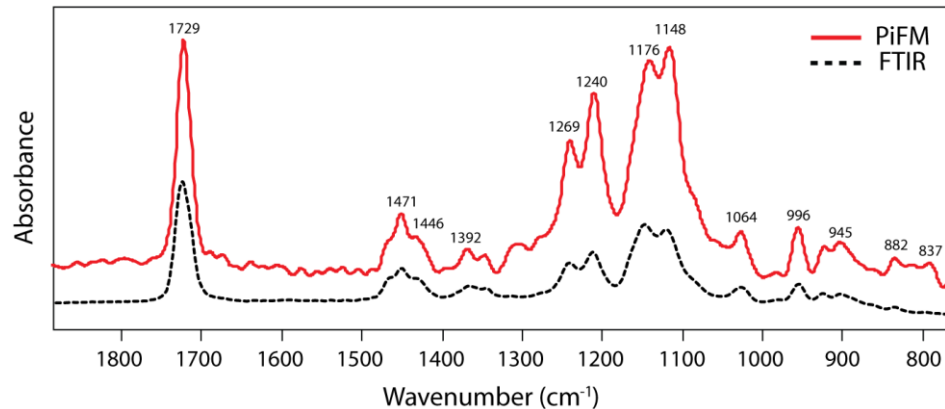
PiFM and FTIR of Nylon



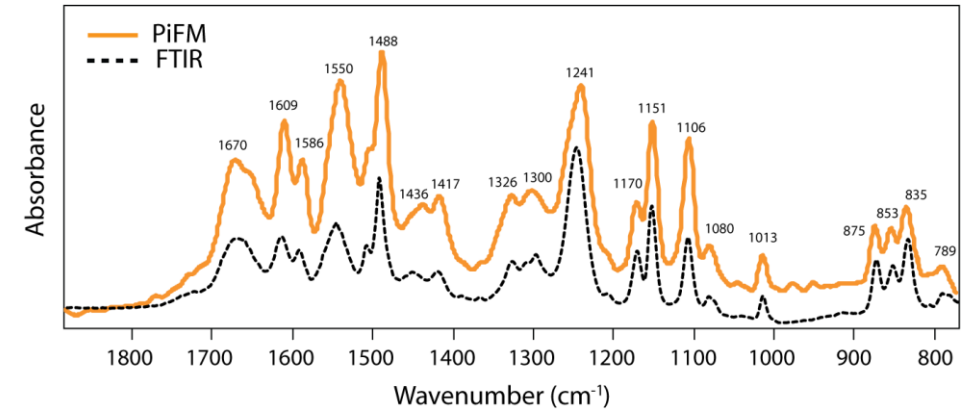
PiFM and FTIR of PES (Polyethersulfone)



PiFM and FTIR of PMMA - Poly(methyl methacrylate)




PiFM and FTIR of Polyimide



Excellent agreement between PiF-IR spectra and FTIR spectra on **homogeneous** samples. Allows the use of IR libraries for defect analysis.

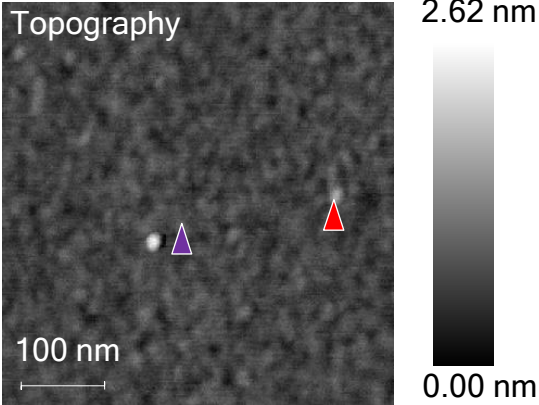




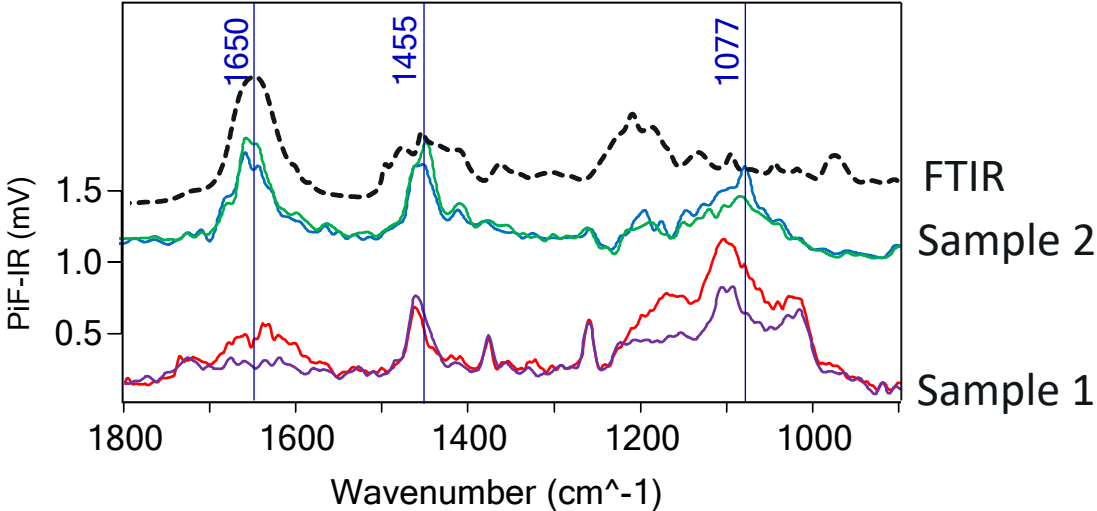
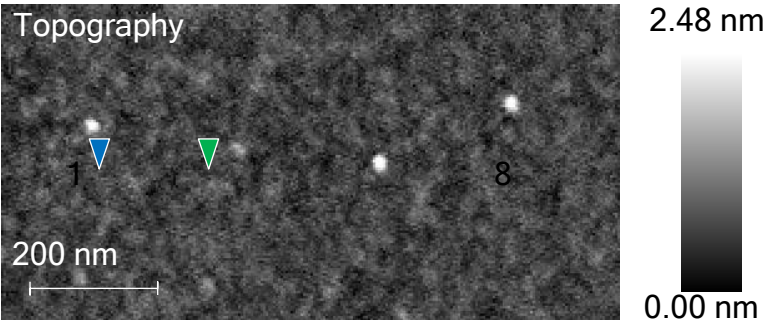
PiFM for Analysis of Sub-20 nm Organic/Inorganic Defects

How can you tell if you have a conformal monolayer film?

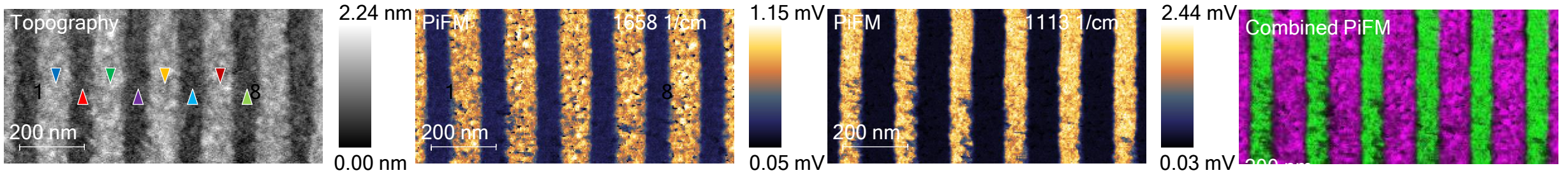
Sample 1, Carboxylic



Sample 2, Hydroxyl

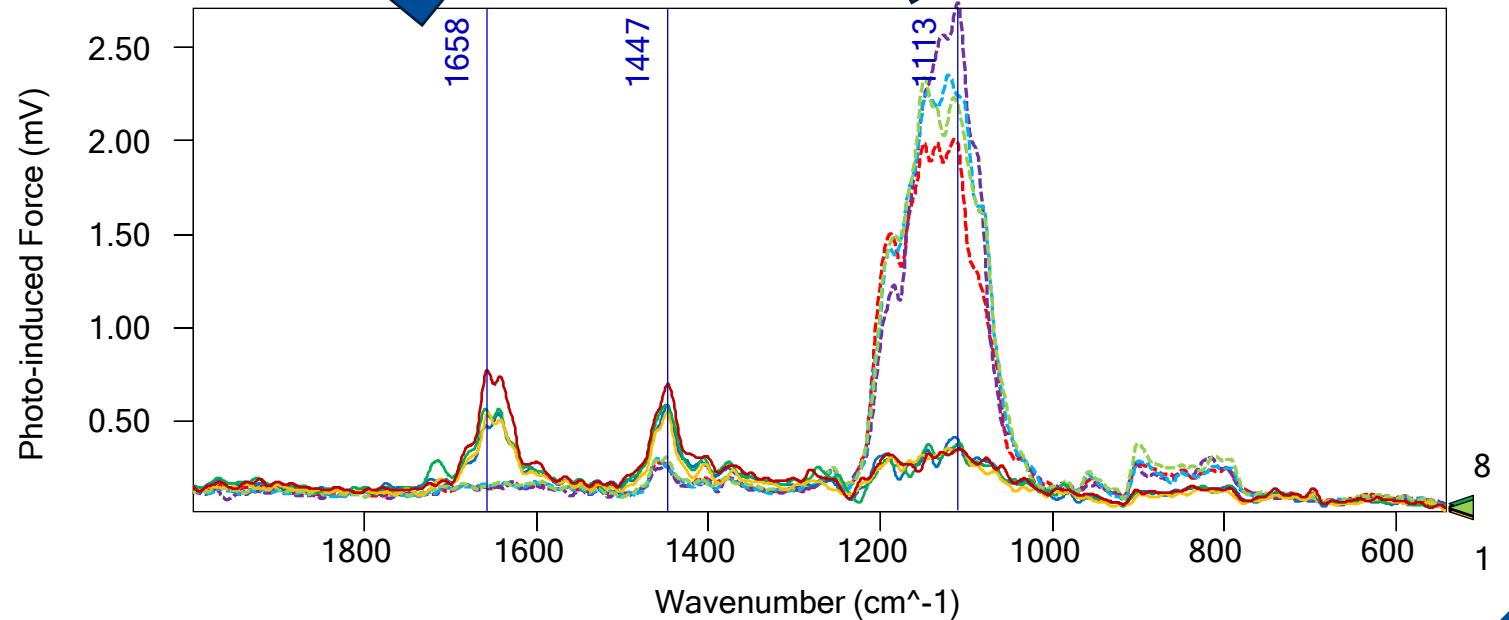


Patterned Polypeptoid Brush Monolayer

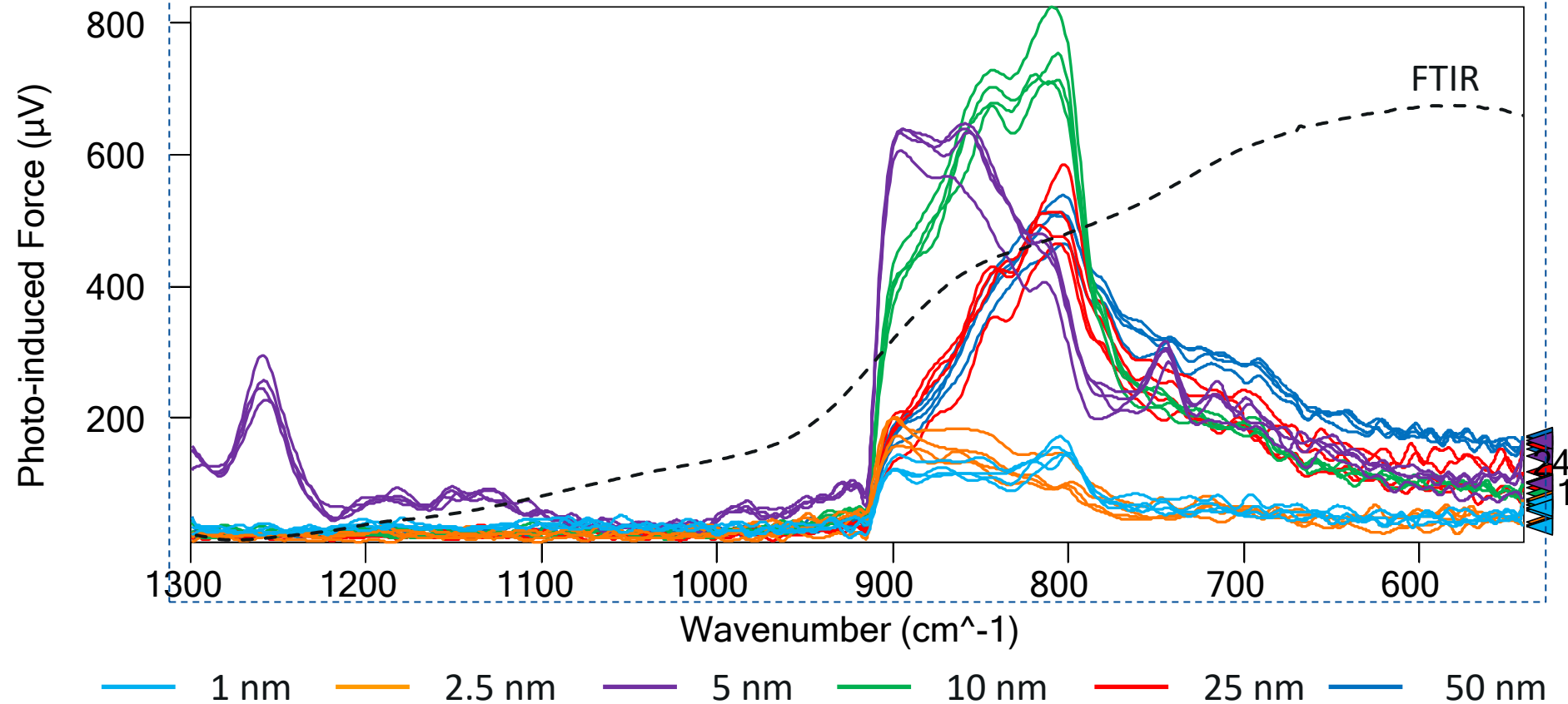


Peptoid (1658 cm^{-1})
 SiO_2 (1113 cm^{-1})

Only $\sim 1\text{ nm}$ thick,
pitch of 170 nm



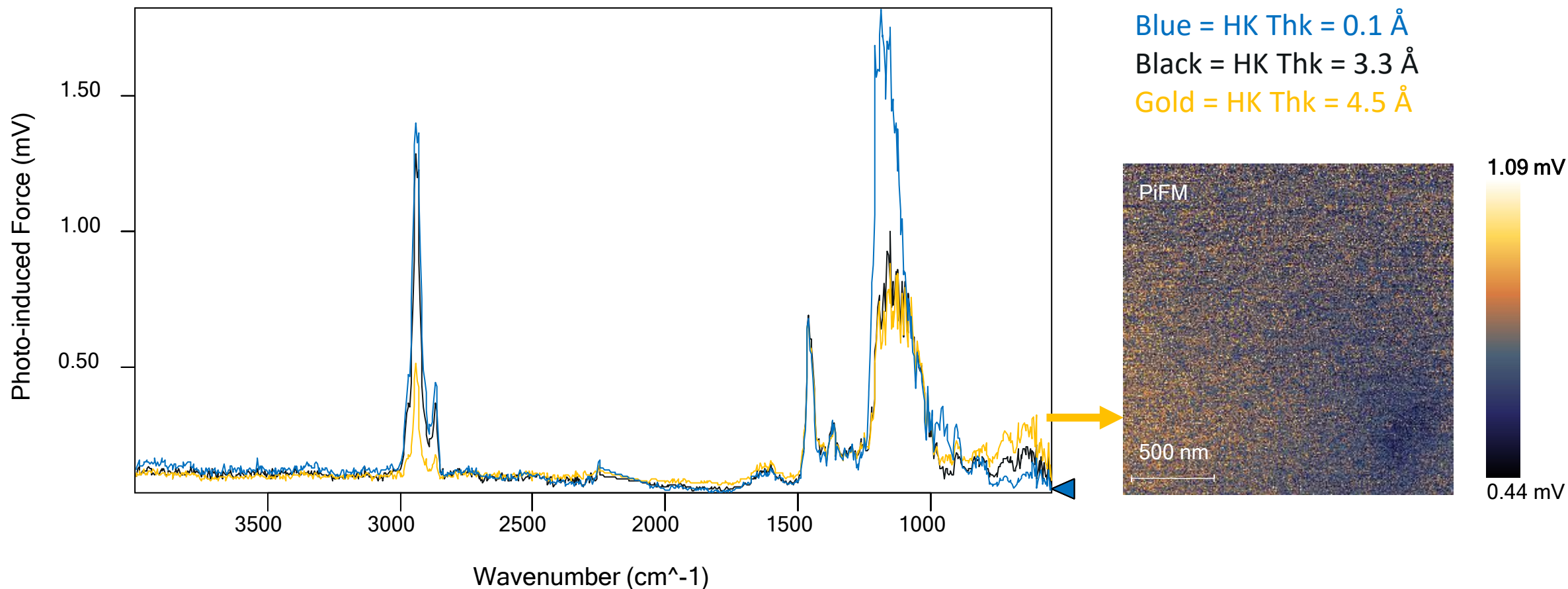
PiF-IR Analysis of ALD Grown Al_2O_3



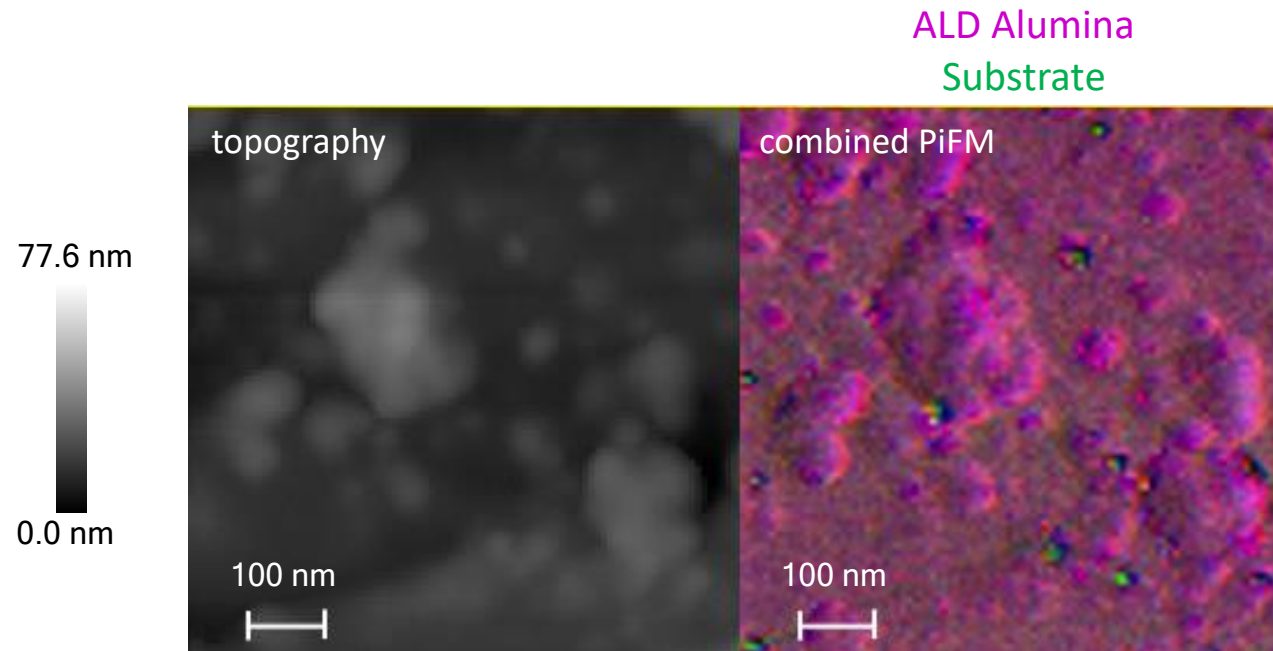
Four spectra (1 μm spacing) are acquired from each sample; they are reasonably repeatable indicating that each sample is homogeneous. Compared to the broad FTIR spectrum, PiF-IR spectra display sharper features that vary with thickness.



High-K Dielectric



PiFM Image of ALD Grown Al_2O_3



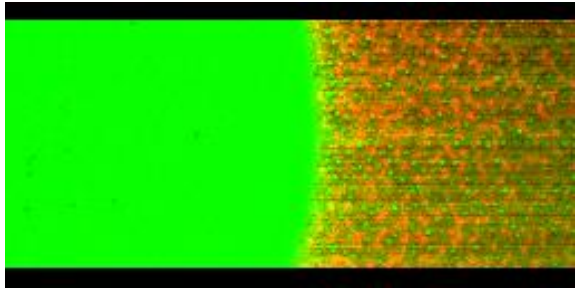
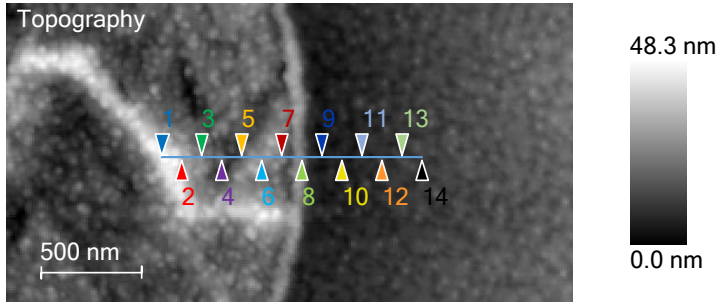
Alumina is grown on top of a substrate material via ALD and examined via IR PiFM. Topography is shown on the left. A combined PiFM image consisting of one PiFM image for alumina (purple) and another one for the substrate (green) clearly shows multiple pinholes (~ 10 nm in size) in the alumina layer.



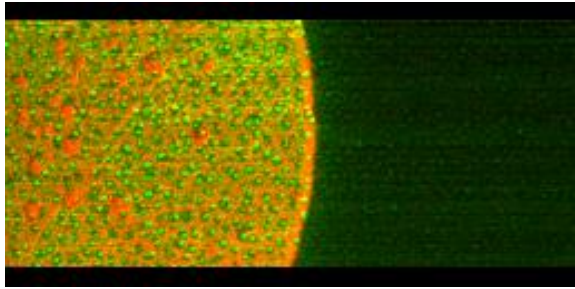


Other Applications

Monitoring Post Glue-clean Wafer



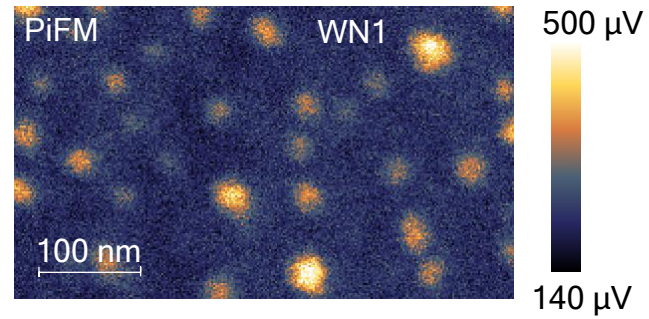
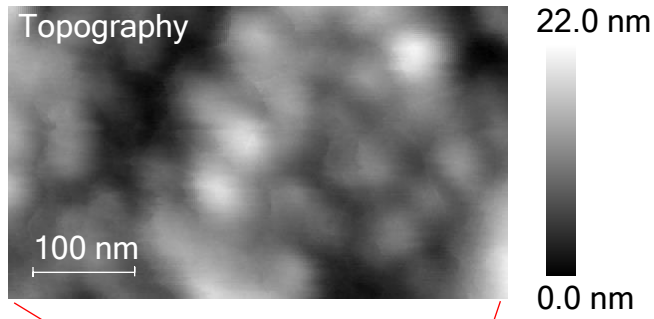
Highlights glue residue at WN1 (green) in the oxide region. The display is adjusted to show the oxide region. Due to the enhanced field enhancement on Cu region, it appears much brighter even at WN1.



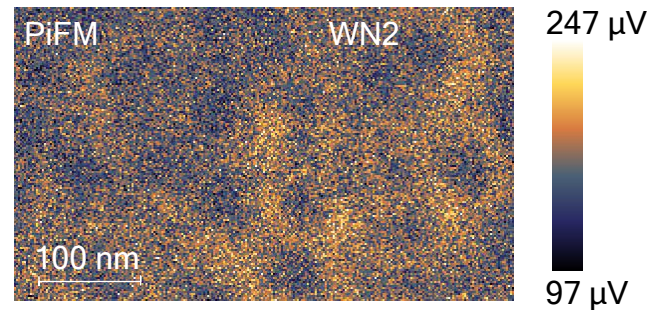
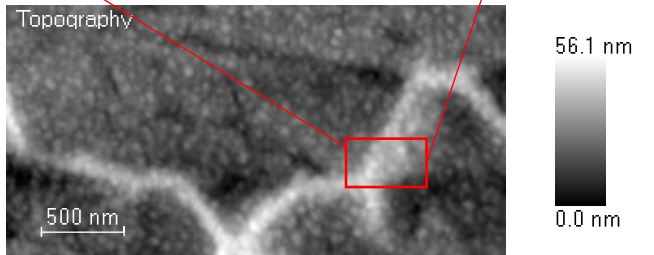
Highlights glue residue at WN1 (green) in the Cu pad region



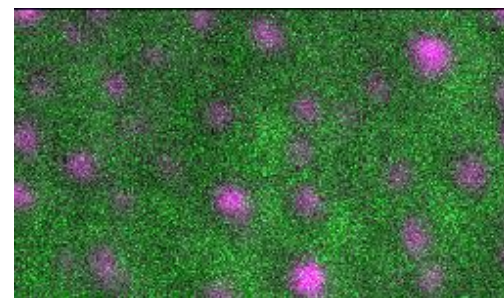
Zoomed-in Cu Pad Region



PiFM image at WN1 highlights the glue that remains even after the cleaning process.



PiFM image at WN2 highlights the Cu^{2+} based compounds (includes CuO and Cu -organic) on the copper pad.



Combined PiFM images show the glue residue (purple) on top of the copper pad (green).



Automated Defect Review via KLARF Coordinates

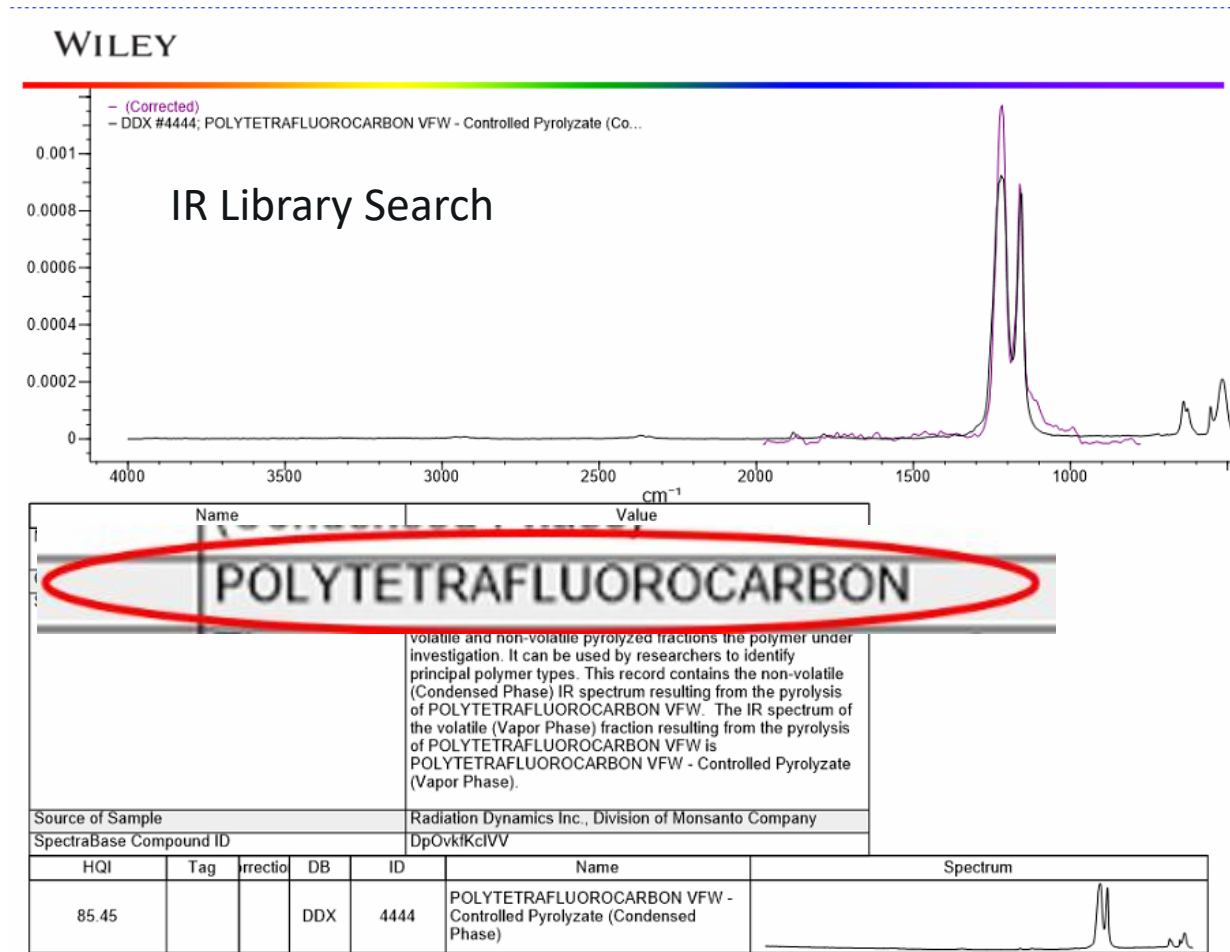
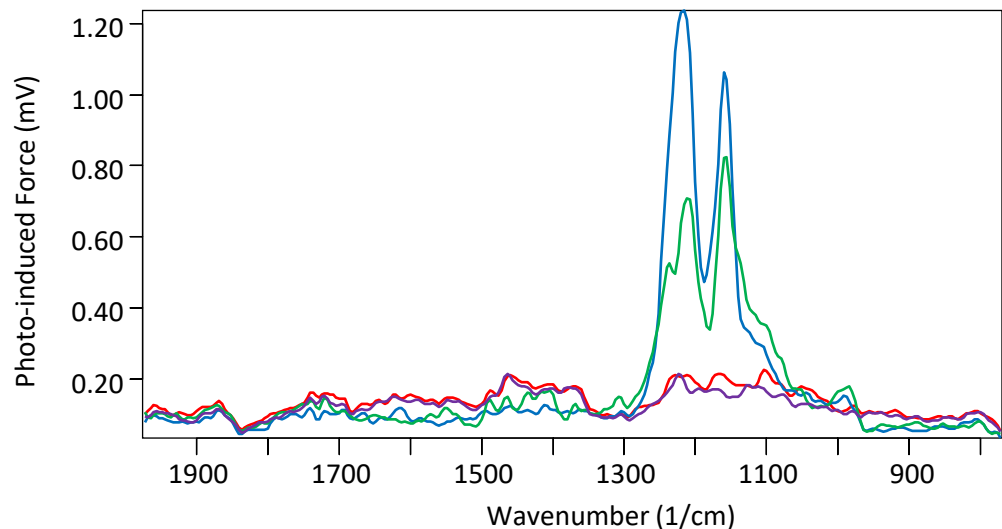
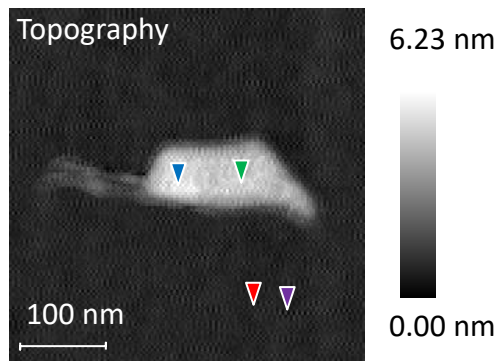
The screenshot displays the KLARF Defect Map software interface. On the left, a circular defect map is shown with a grid and a red box highlighting a specific defect labeled "Defect #943". Below the map are controls for "Adjust Point Size" (1x, 10x, 100x, 1000x) and "Lasso Select". The main area features a data table with columns for DEFECTID, XTRANSLATED, YTRANSLATED, and DSIZE. A right-hand panel contains filter settings, including "Column to Filter:", "Filter Type" (Min, Max, Equal), and "Add Filter". At the bottom, there are "Cancel" and "Import" buttons.

DEFECTID	XTRANSLATED	YTRANSLATED	DSIZE
1	150463000	157089000	1668
2	150510000	157175000	26176
3	150536000	157260000	55571
4	150542000	157343000	58358
5	150517000	157435000	42529
6	150525000	157521000	41117
7	161223000	152611000	2292
8	161299000	152655000	76773
9	161387000	152668000	90608
10	161472000	152705000	75958
11	161557000	152721000	72292
12	139857000	162772000	35592
13	139800000	162847000	50783
14	139763000	162918000	102198
15	139716000	163003000	130518
16	139662000	163071000	138305
17	139595000	163130000	122068
18	139523000	163194000	84818
19	139495000	163272000	17347
20	135460000	157638000	18523
21	135400000	157705000	66252
22	135311000	157743000	87538
23	135246000	157811000	135062
24	135163000	157843000	156570
25	135081000	157883000	158978
26	134990000	157892000	115898
27	134152000	157425000	25056
28	134060000	157439000	81941
29	133978000	157461000	101969
30	133870000	157457000	118369
31	133783000	157462000	92523
32	133688000	157475000	59673
33	133621000	157555000	3233
34	133589000	157484000	14166
35	133512000	157517000	10673



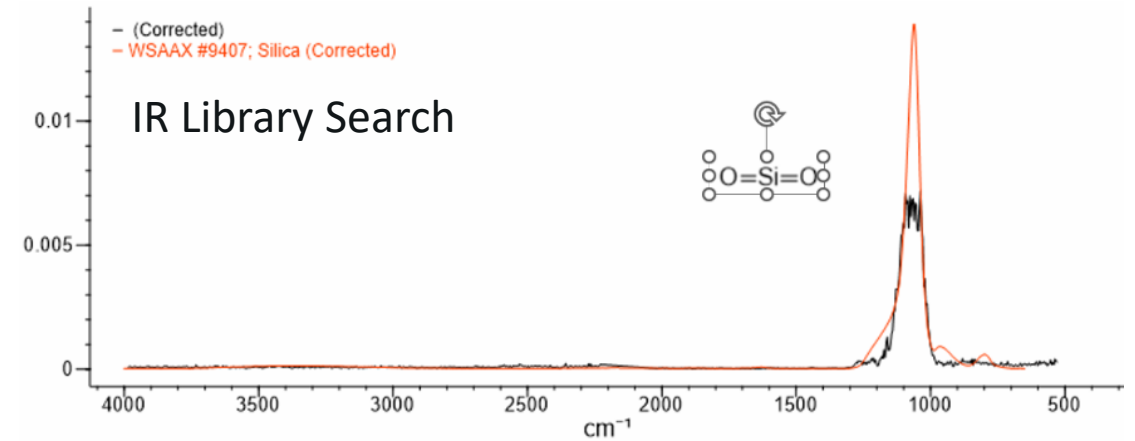
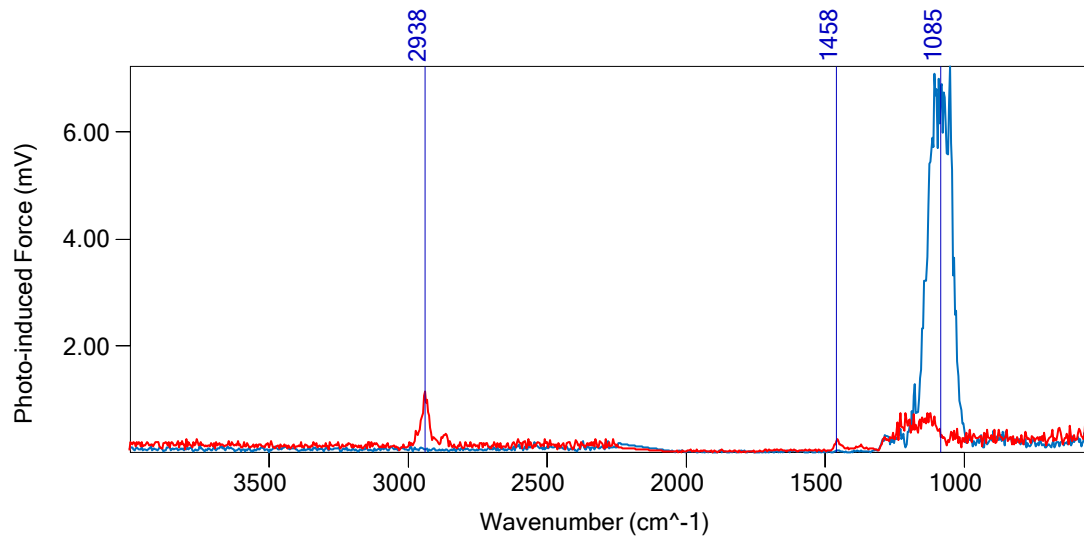
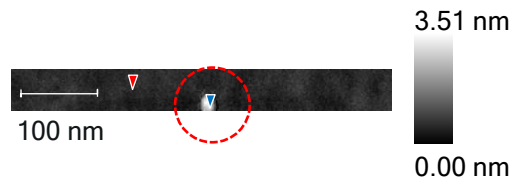
Sub-100 nm Organic Defects on Wafers

~ 5 nm thick, 50 nm x 100 nm



Sub-100 nm Inorganic Defects on Wafers

~ 3 nm particle

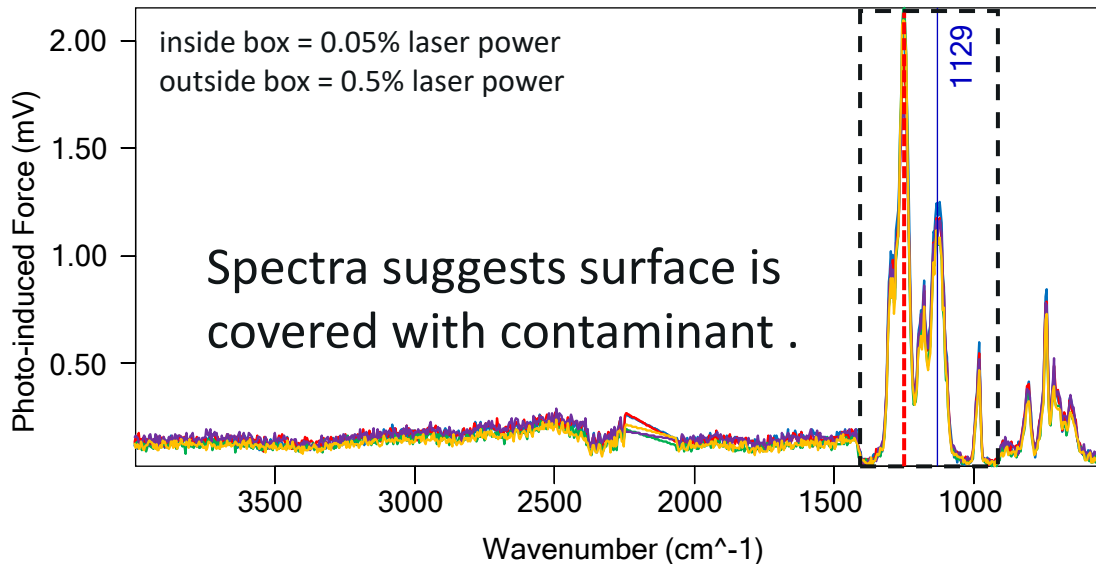
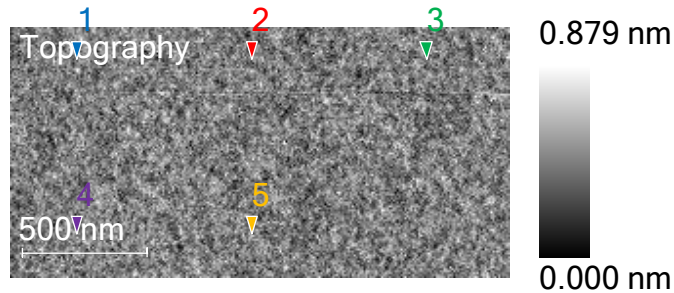


HQI	Tag	Correctio	DB	ID	Name
87.43			WSAAX	Silica	



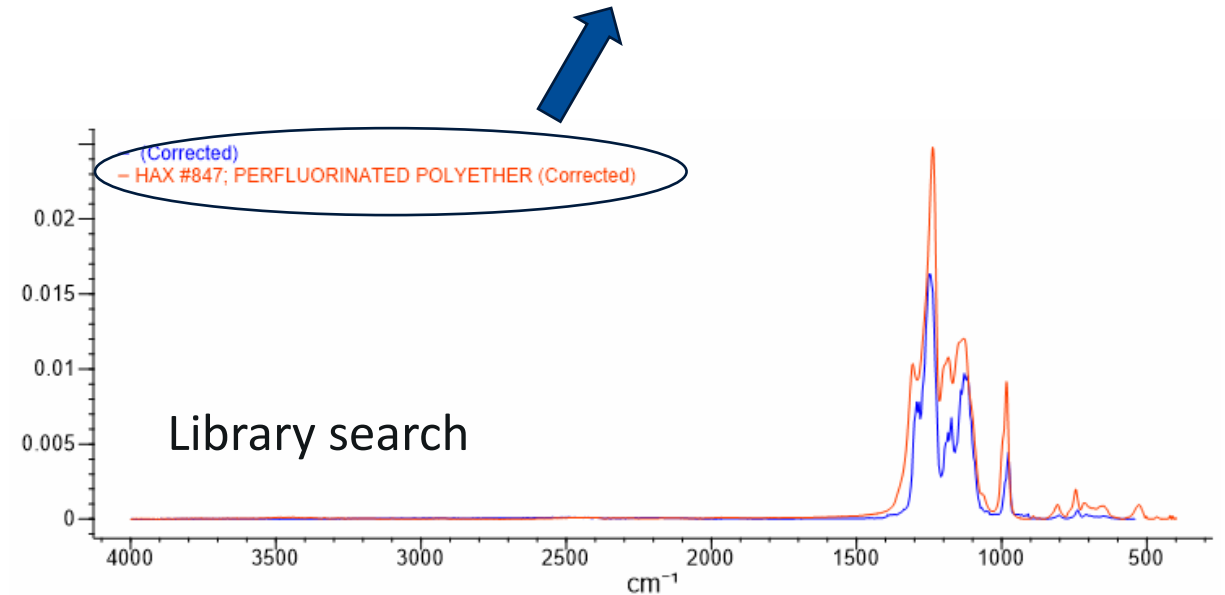
PFPE Contamination Monolayer on a Wafer Surface

Topography reveals a standard flat wafer surface.



Given the micro-roughness and repeatable PiF-IR spectra, most likely a conforming monolayer.

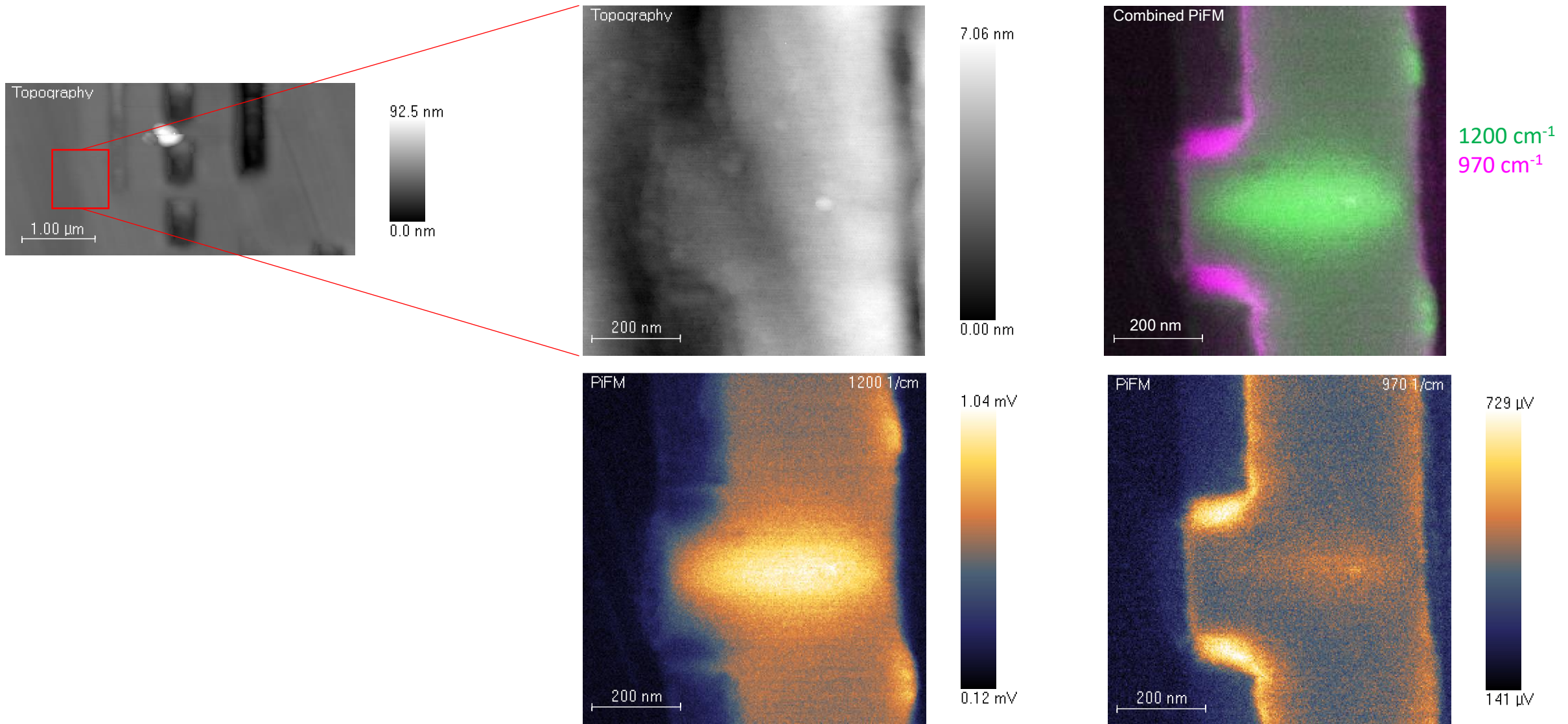
Contaminated with perfluoro polyether (PFPE)



HQI	Tag	rrrectio	DB	ID	Name
83.20			HAX	848	PERFLUORINATED POLYETHER



Cross-section Analysis



Summary

- IR PiFM is introduced.
- PiFM measures sample's IR absorption via mechanical force detection.
- It provides for exceptional spatial resolution (< 5 nm), excellent surface sensitivity (monolayer), and ease-of-use.
- Vista-IR is a turnkey PiFM systems with visible to mid-IR lasers.
- Vista-IR can characterize SAM, ALD, and ALE processes based on the materials' IR signatures.
- Applications to monolayer/surface characterization and nano defect analysis were shared.

- Covalent Metrology has one of our tools and can provide analytical services.
- You are welcome to contact us to discuss your application needs:
info@molecularvista.com.





Thank You!

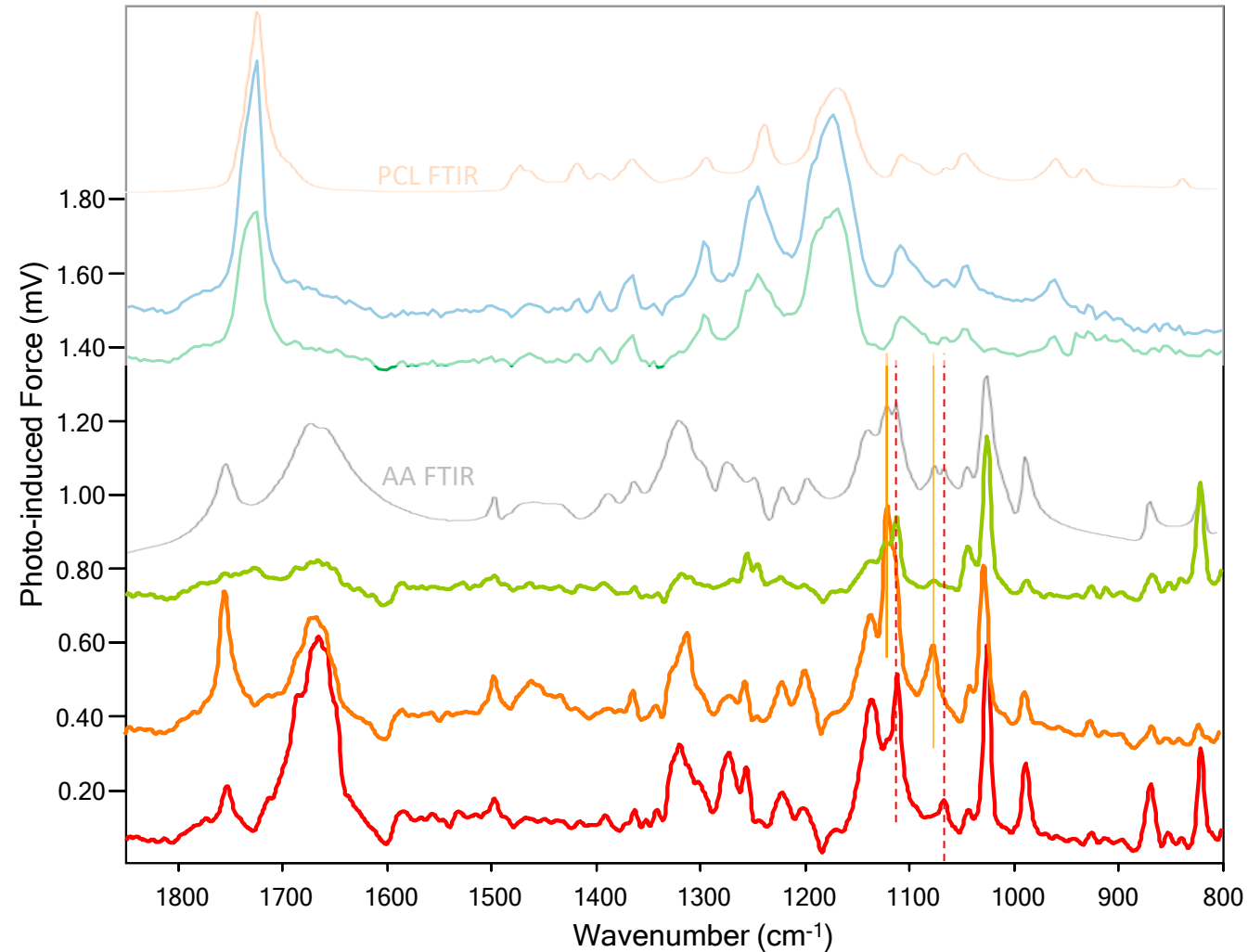
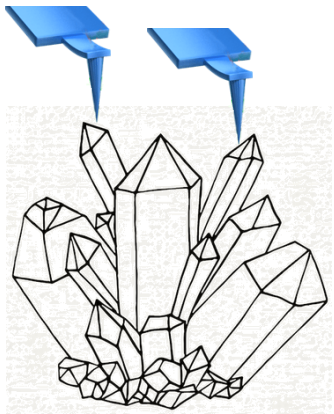
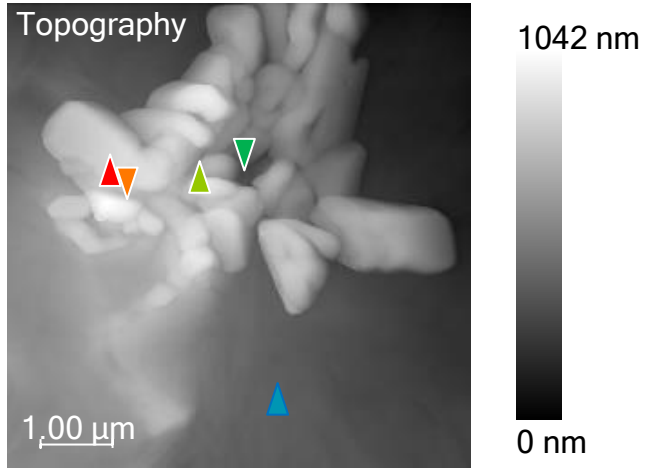




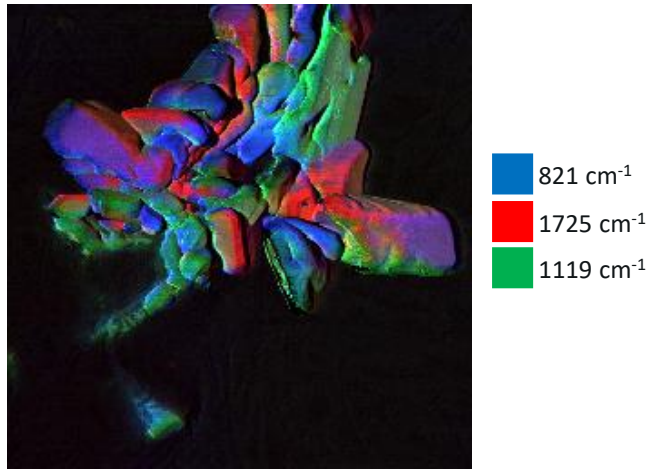
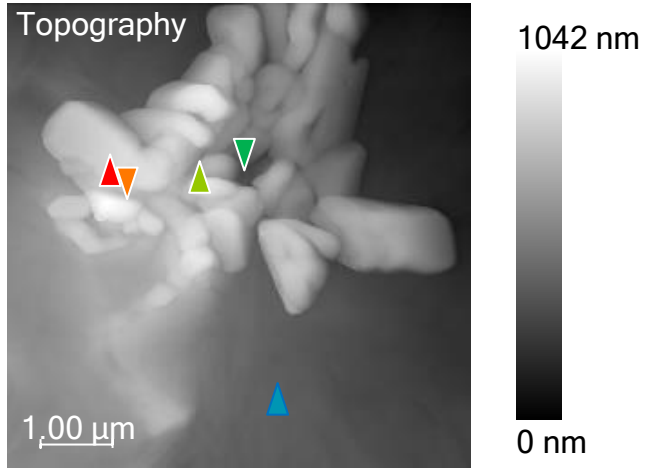
Molecular Orientation and PiFM

Discrimination of molecular orientation

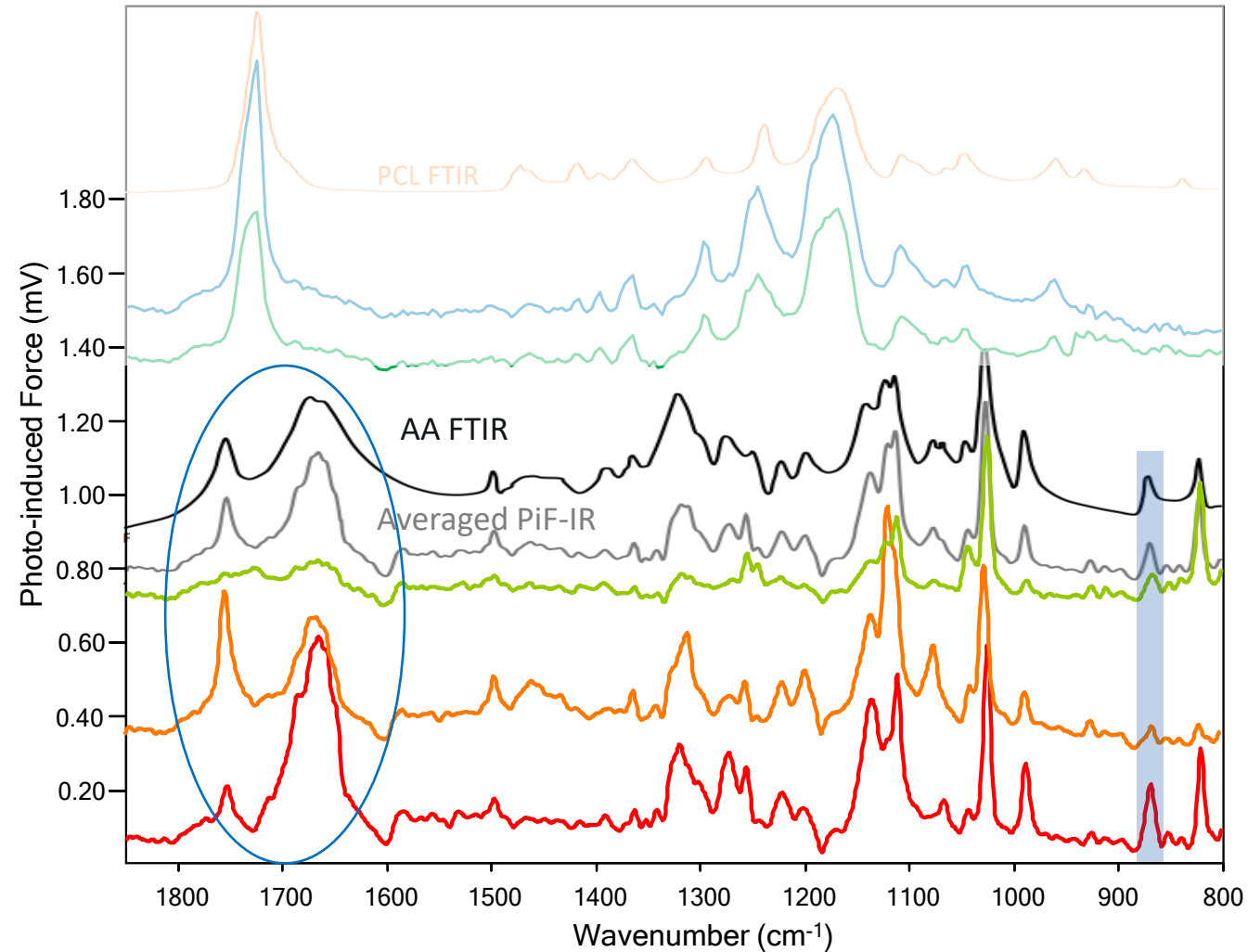
Poly(e-Caprolactone)/Ascorbic Acid (PCL/5AA) – AA Crystals



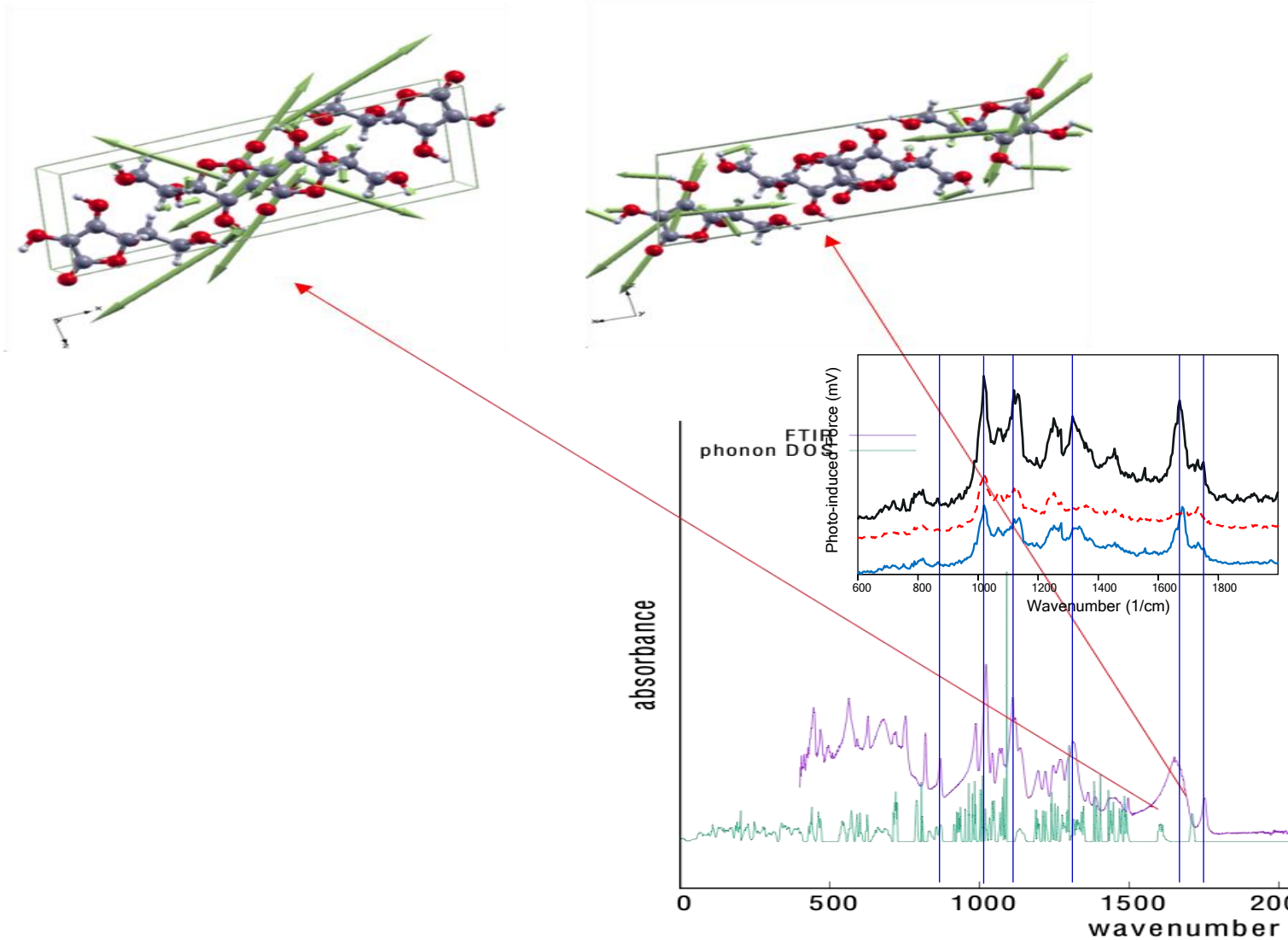
Discrimination of molecular orientation



Ensemble averaged FTIR versus local PiF-IR spectra



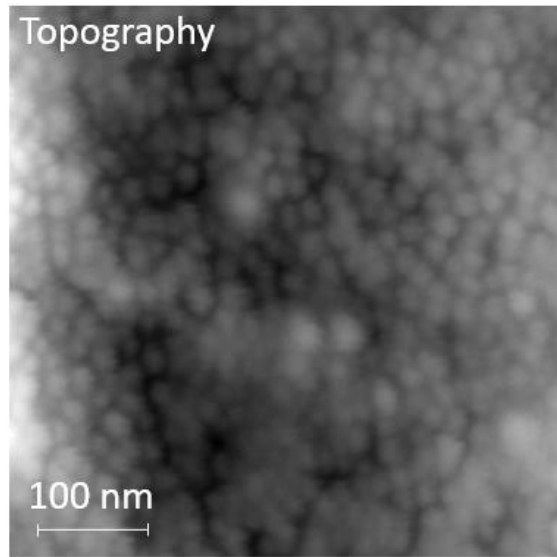
Understanding & Modelling of IR Peaks of AA



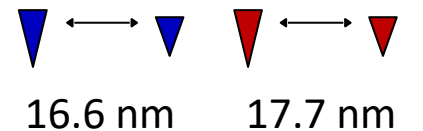
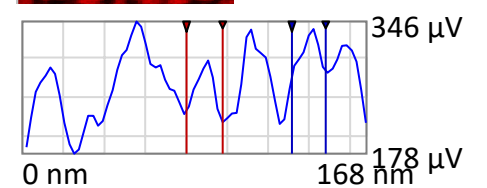
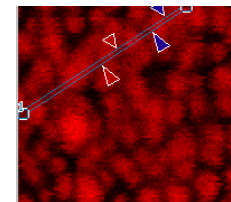
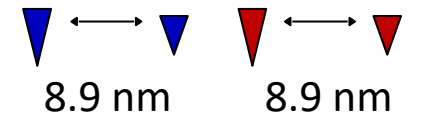
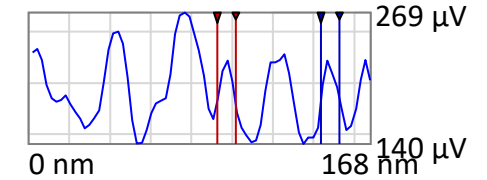
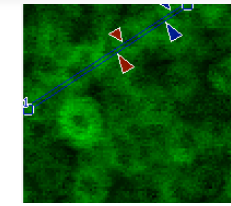
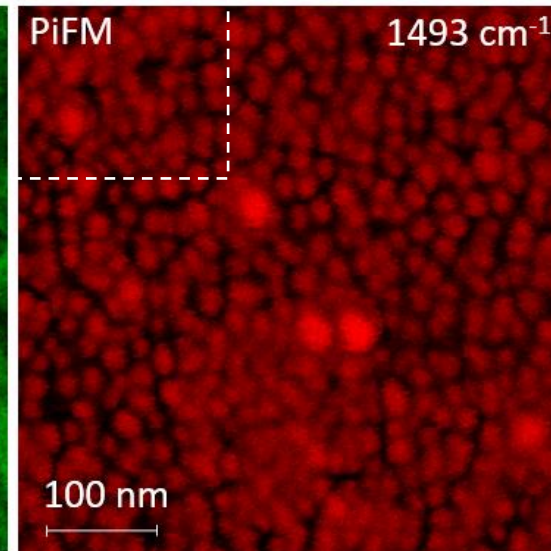
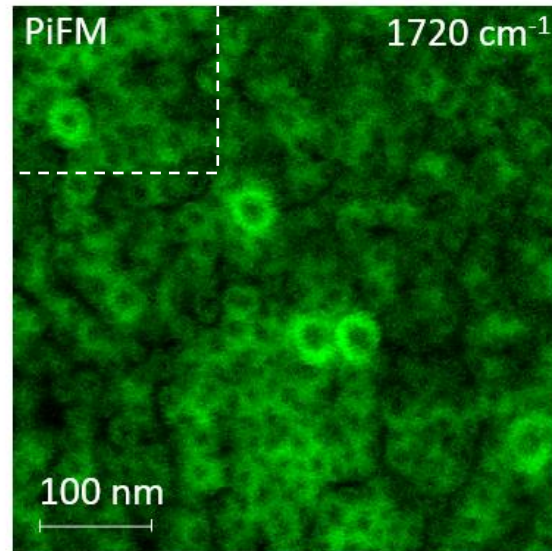
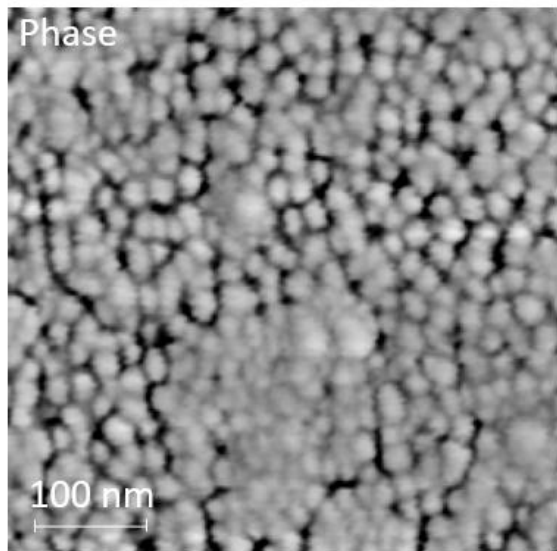
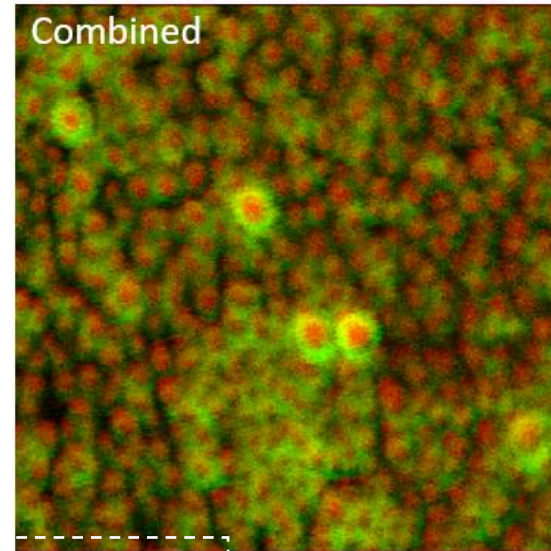
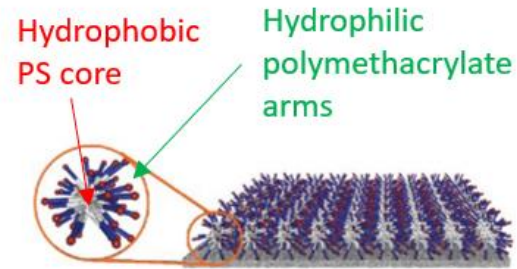
We are planning scanning nanobeam electron diffraction (SNBED) analysis on the same measurement locations to correlate local crystal structure to phonon vibrations.



Core-Shell Structure

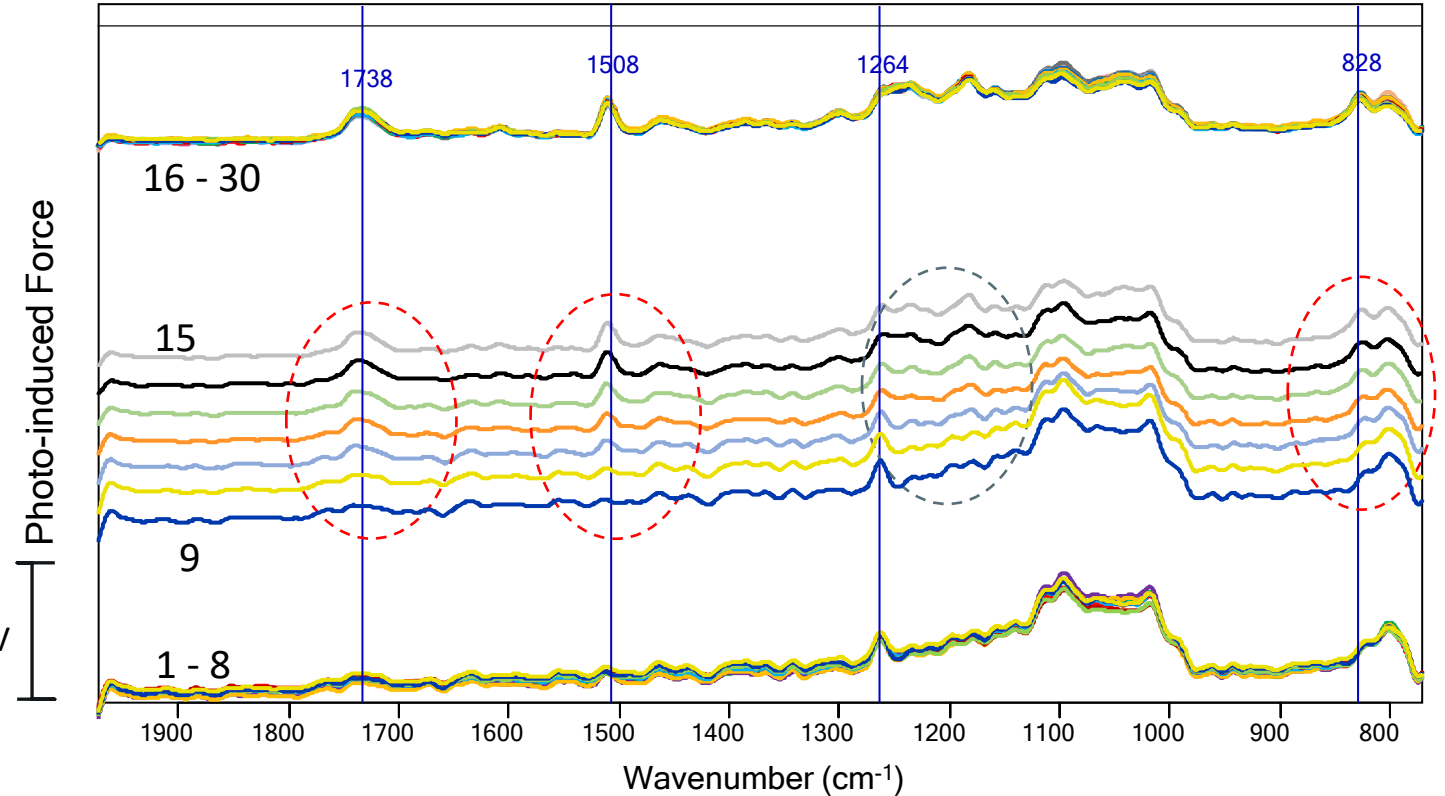
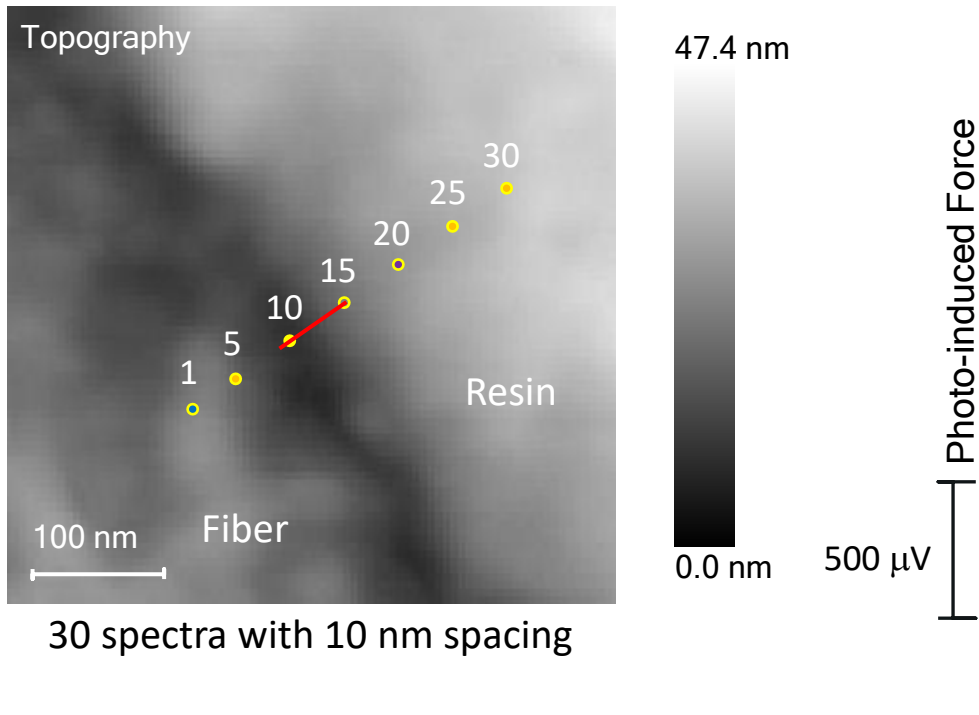


Core-Shell Star Block Copolymers



Excellent Repeatability

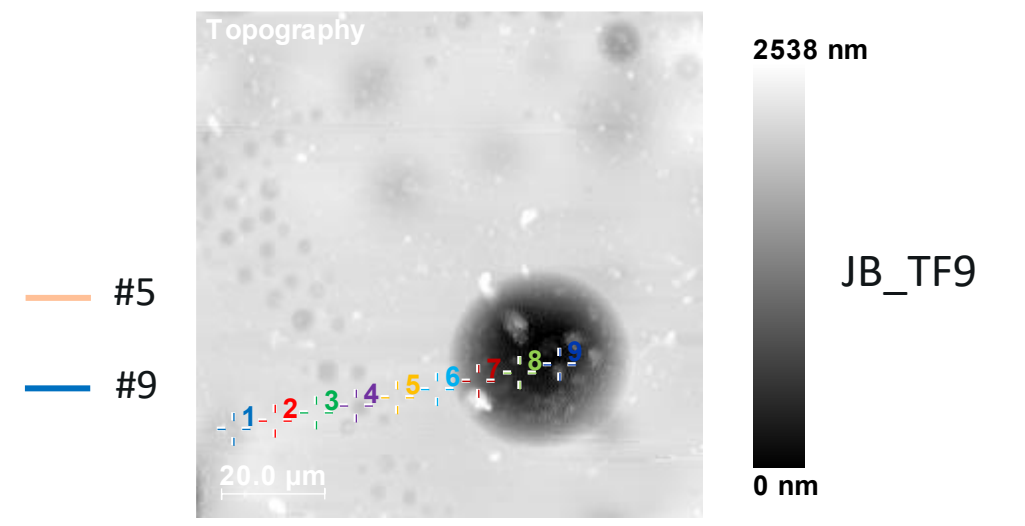
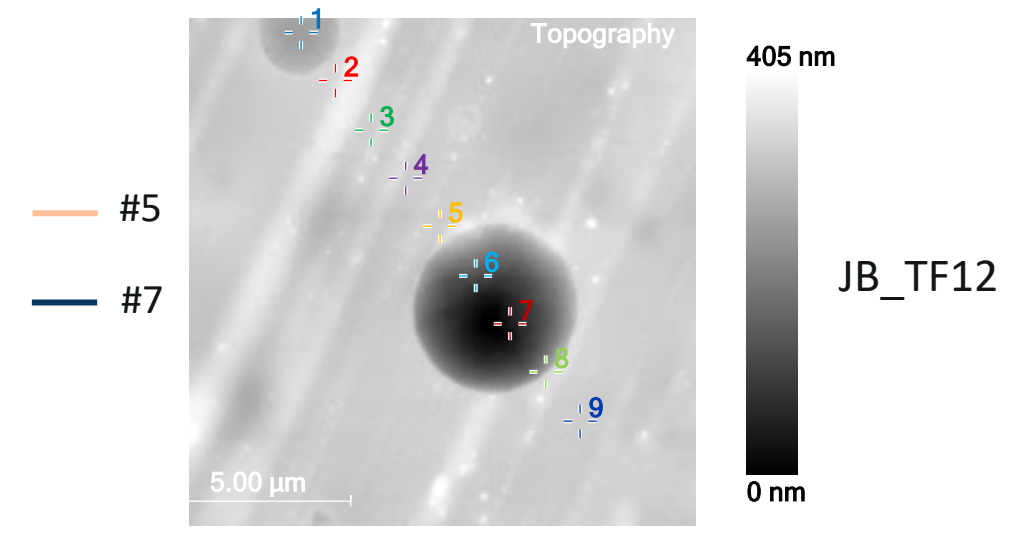
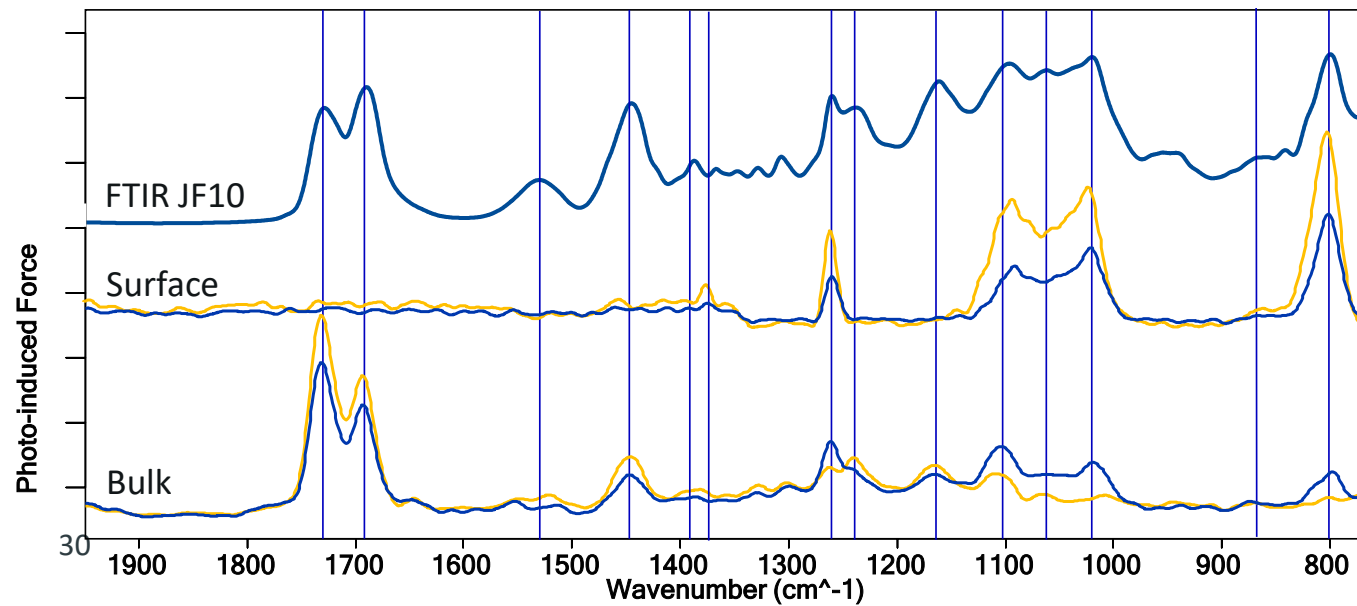
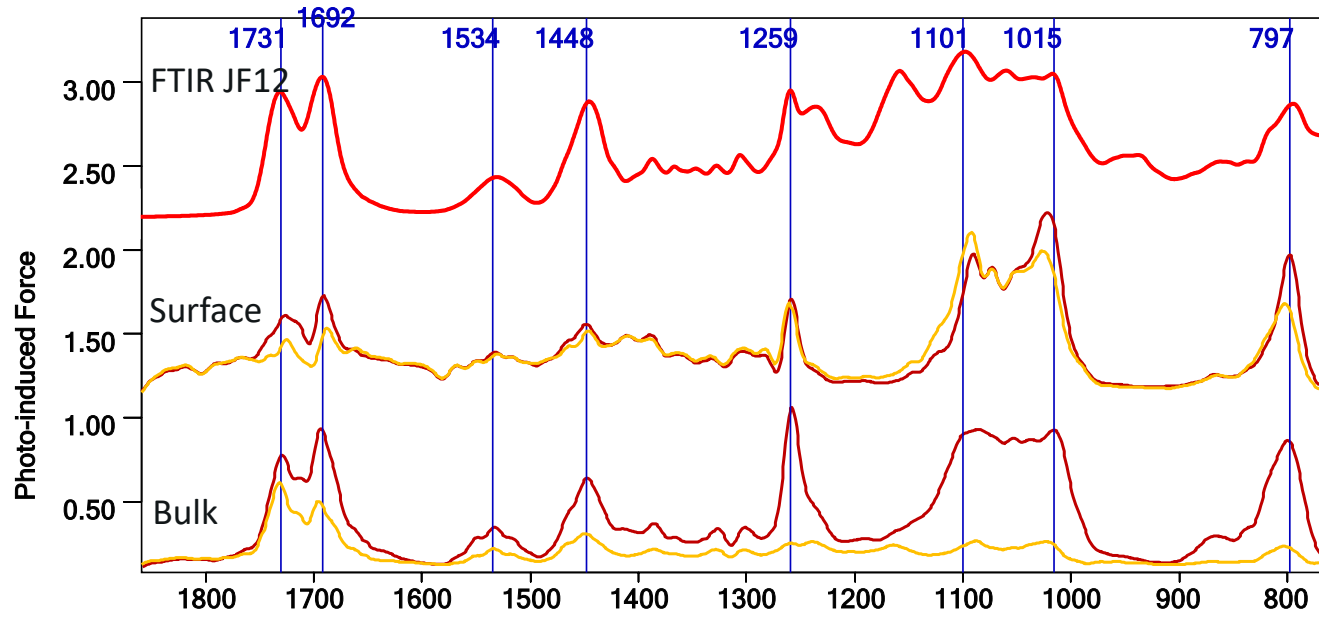
Carbon Fiber-Resin Interface



The interface between a carbon fiber and resin are analyzed by preparing a cross-section of the composite fiber via microtome. 30 PiF-IR spectra are acquired across the interface with ~ 10 nm spacing. The first 8 spectra in the carbon fiber and the last 16 – 30 spectra are very repeatable, with all the spectral changes taking place over 9 – 15 spectra. The SNR is good enough to discern chemical changes for each 10 nm changes in spatial location.



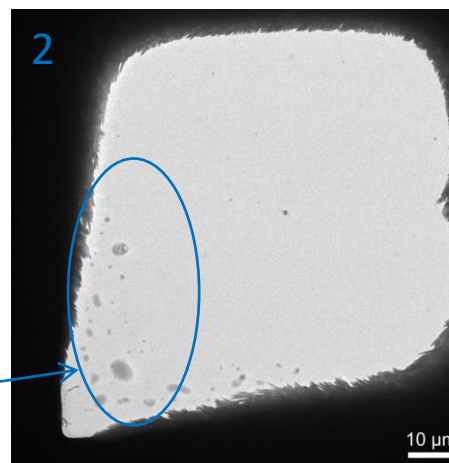
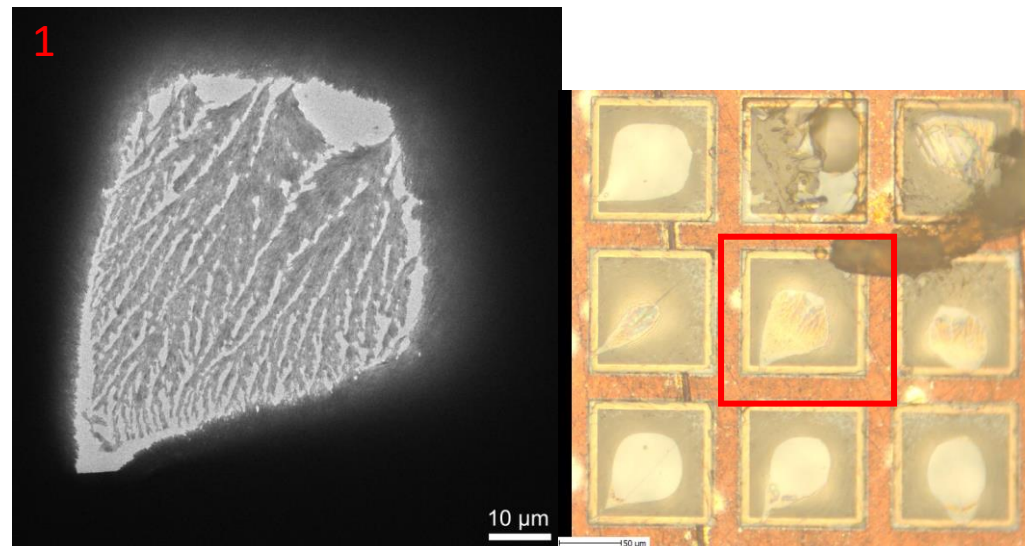
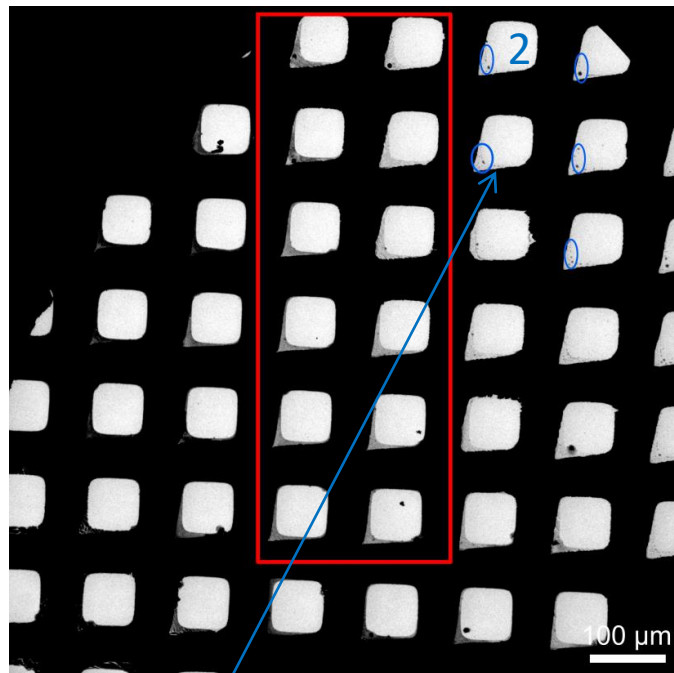
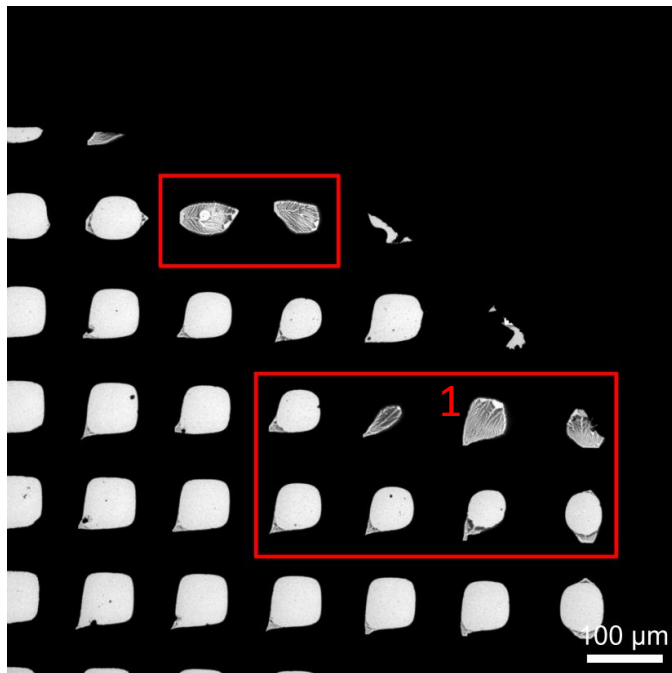
3D Chemical Analysis with Combined Surface and Bulk Modes



Sample Information

Sample description (Grid 2)

The majority of the grid spaces area are usable, but most of the crystals were recrystallized only along the edge of the grid spaces. I highlighted some areas that contain more crystals (red boxes).

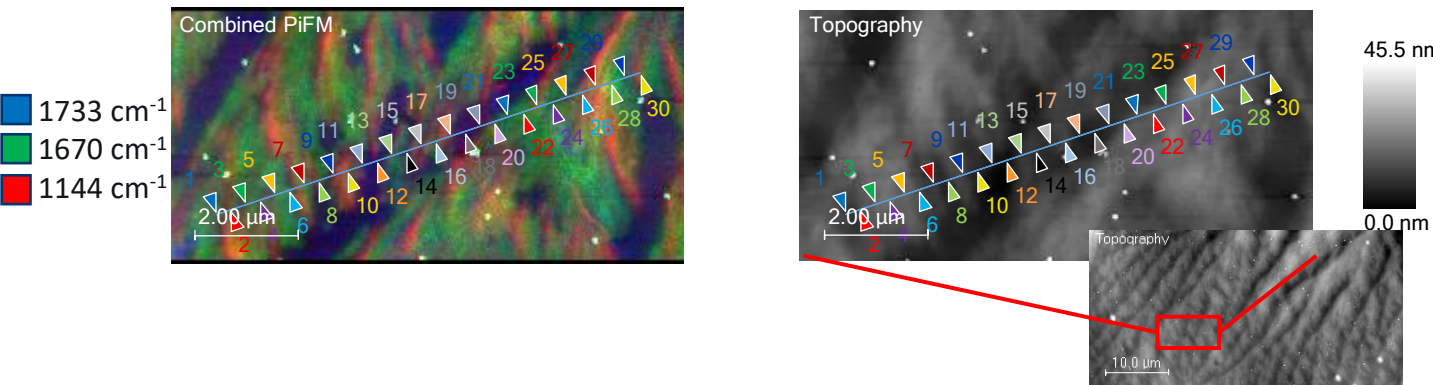


non-crystalline contamination

The optical image from Molecular Vista Microscope is shown above. The sample we measured is the Grid 2, same area with the No. 1 as the sample information shows.

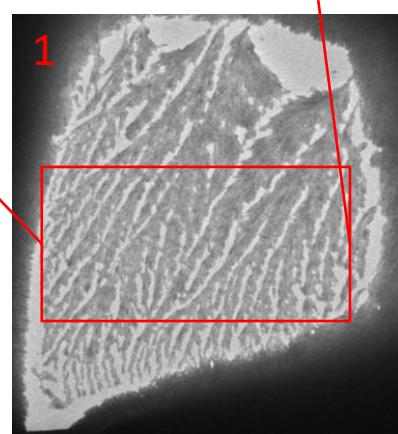
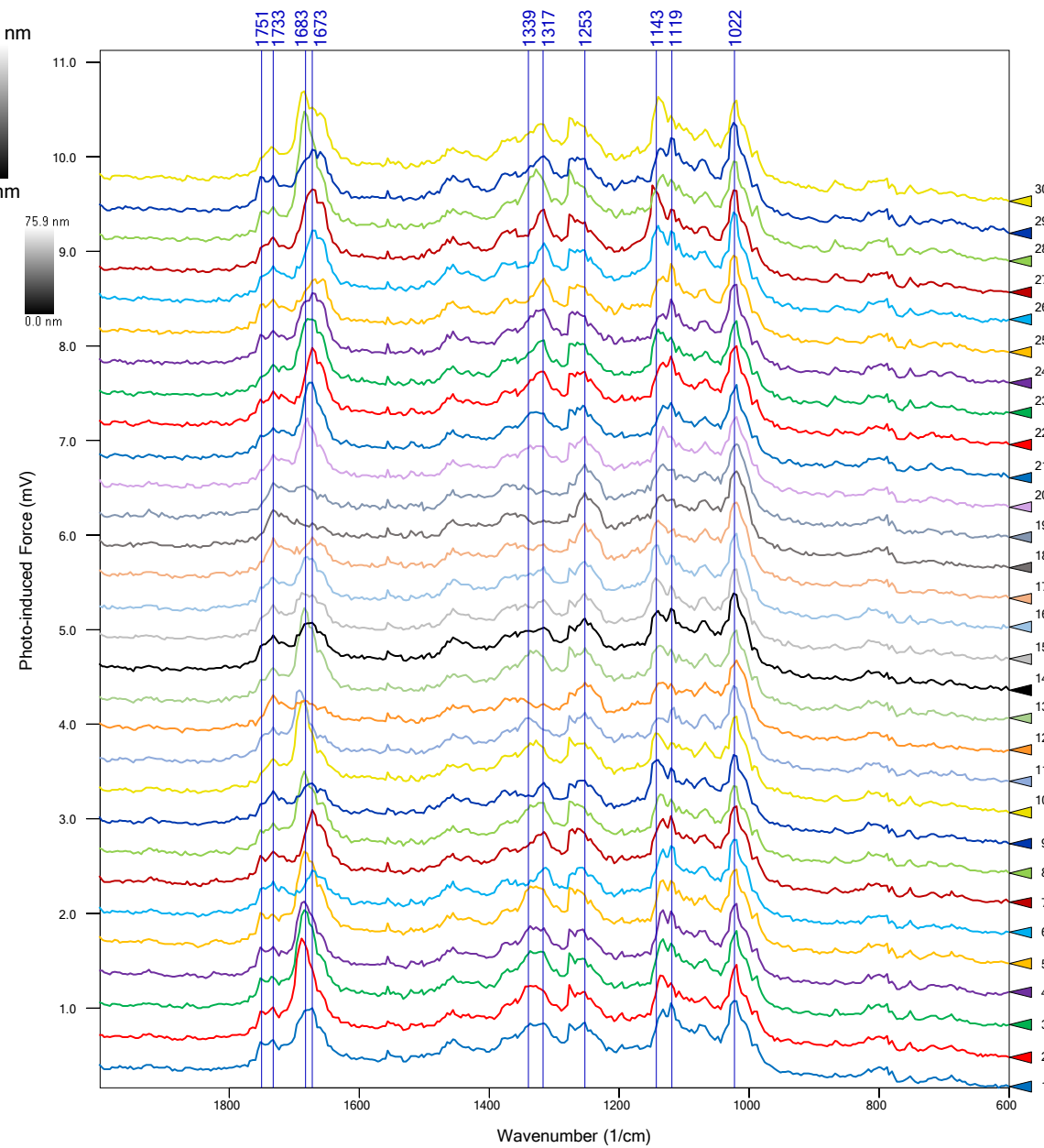


PiF-IR: 10 x 5 μm^2

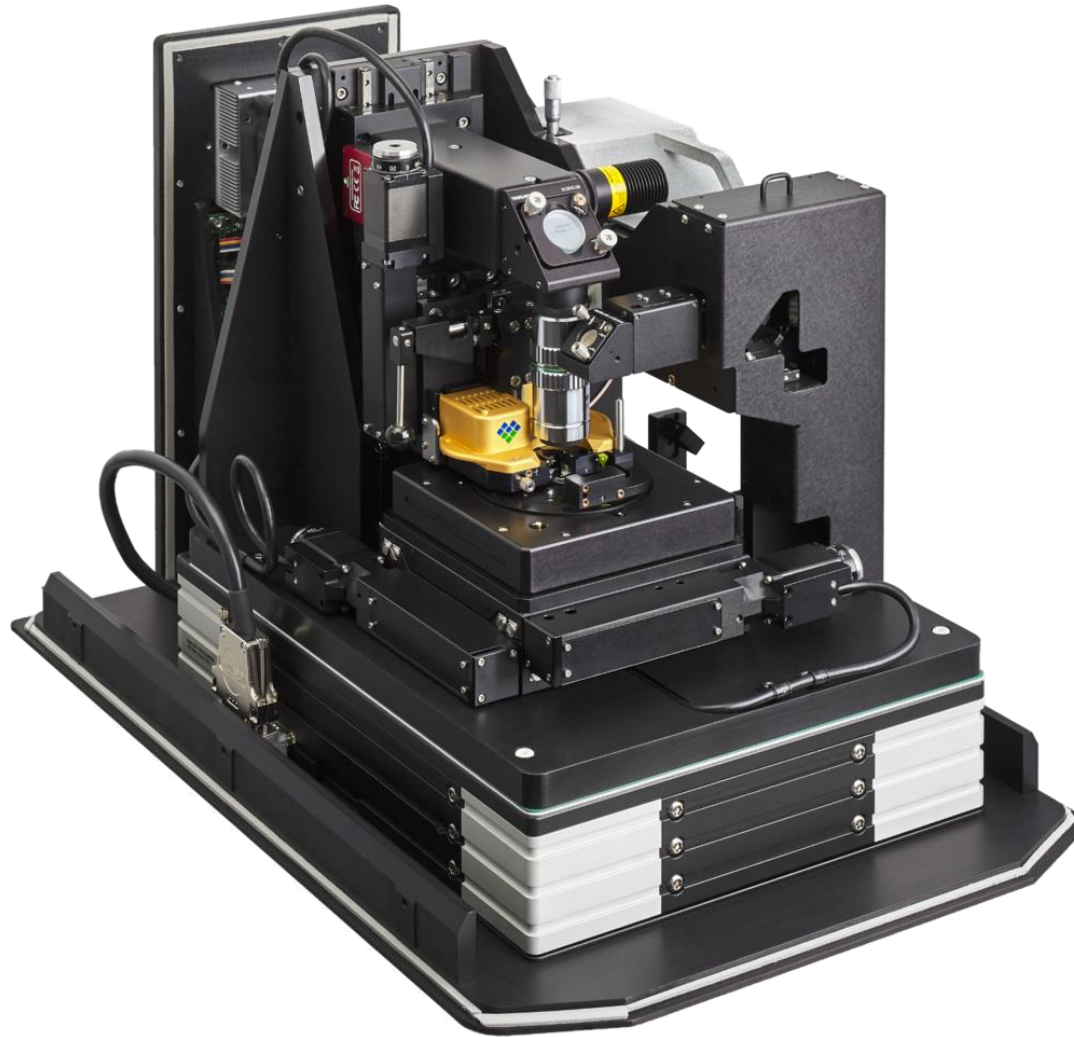


The combined PiFM image shows the crystals are highlighted with two different colors: red and green. And the lower regions are highlighted as blue and purple.

The line spectra with 300nm pitch were taken across the features. The green highlighted regions show peaks around 1751, 1733, 1683, 1673, 1339, 1317, 1252, 1143, 1119, and 1022 cm^{-1} . However, the red highlighted regions show a stronger peak around 1143 cm^{-1} than the green highlighted regions. The blue and purple regions show distinct decreasing of IR signal around 1683 and 1673 cm^{-1} , but a little bit stronger peak around 1733 cm^{-1} .



Nano-scale FTIR & AFM



Vista 75:
Smaller Foot-print for the Same
Great Nano-chemical Metrology
(for samples up to 100 mm in size)



Nano-scale FTIR & AFM



Vista 300:

The Most Advanced Nano-Chemical Metrology Instrument
for R&D and Defect Analysis in Nanofabrication
(for samples up to 300 mm wafer)



Chemical Mapping: SEM/TEM EDX

Atomic Resolution Elemental Mapping on SrTiO₃ crystal by Super X EDS (EDX) system on Titan 80-300 Aberration Corrected Scanning Transmission Electron Microscope

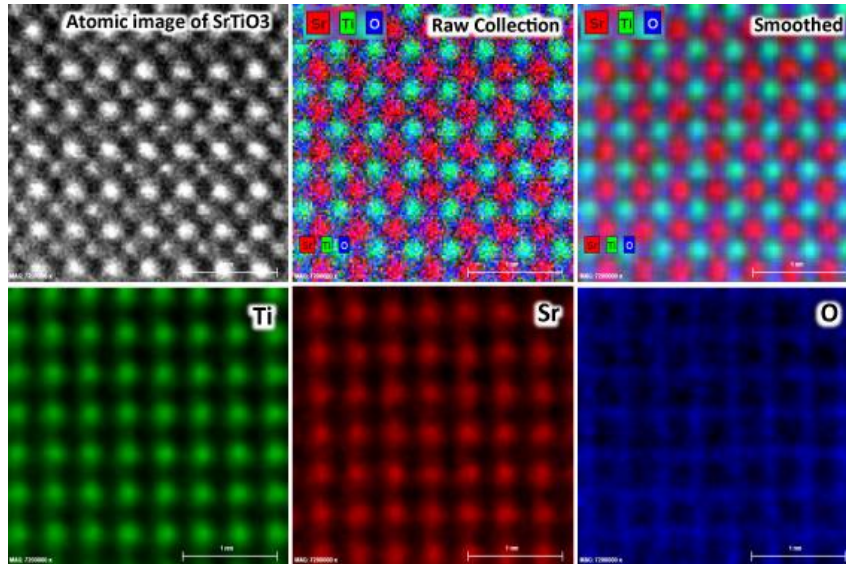


Image credit: North Carolina State Univ. Analytical Instrumentation Facility
<https://www.aif.ncsu.edu/tem-lab/>

Elemental mapping of a device structure by EDS (EDX)

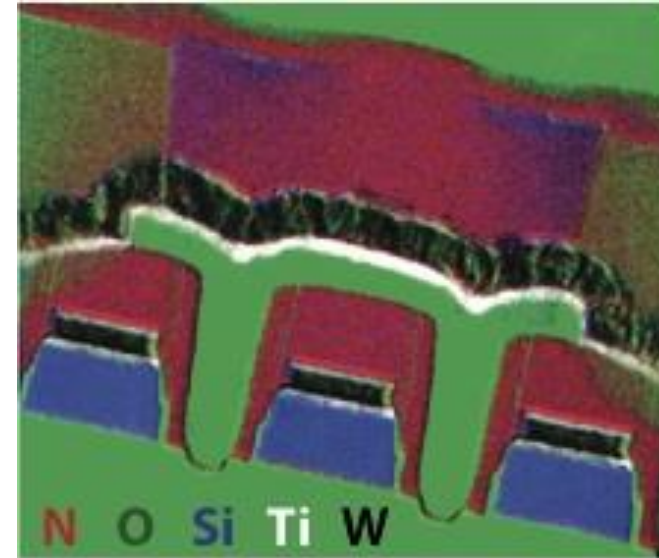
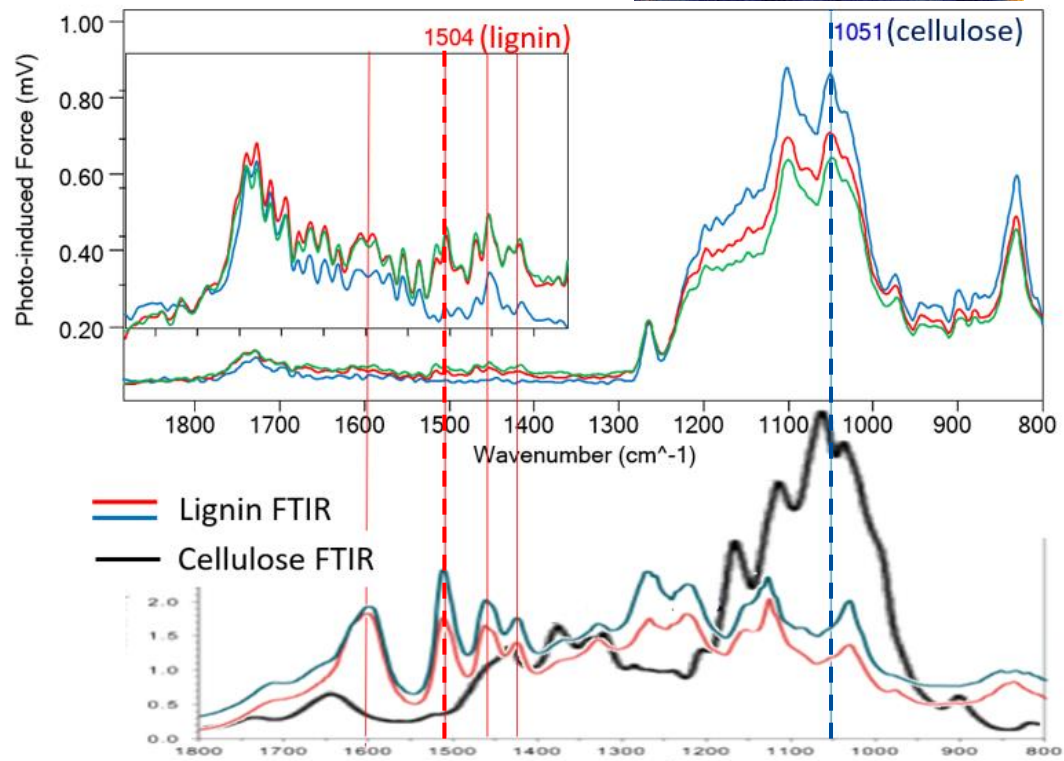
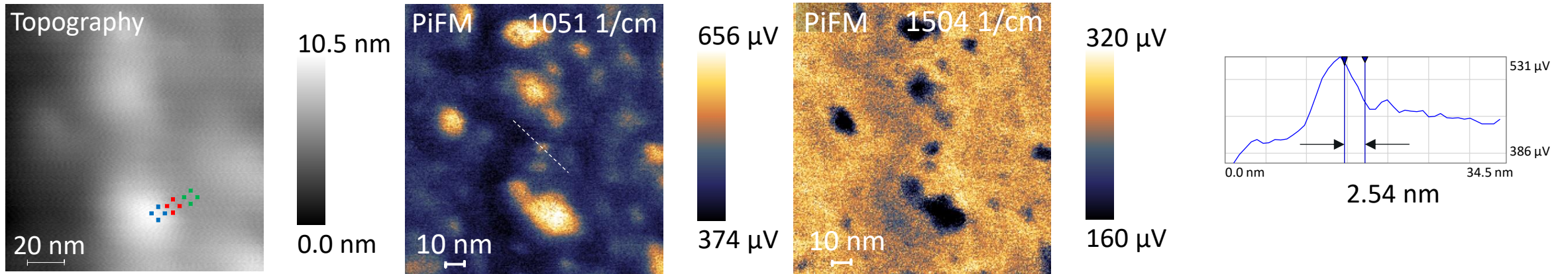


Image credit: Nanolab Technologies
<http://www.nanolabtechnologies.com/TEM-STEM-EELS-EDS>

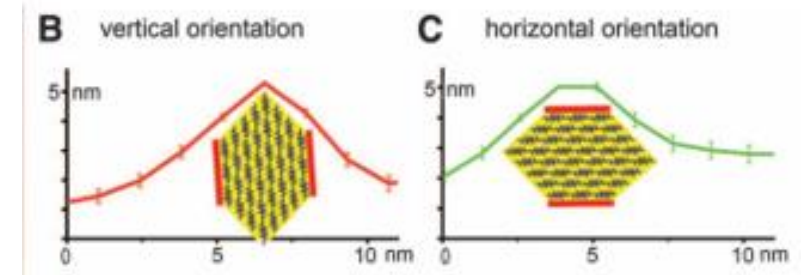
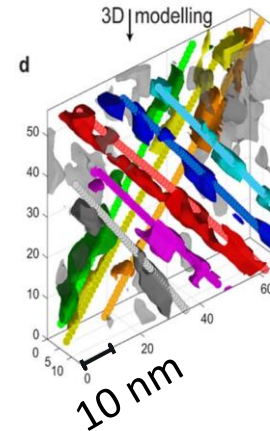
- Advanced capability for elemental mapping, but
- No molecular information
- Not effective for organic materials



AFM vs IR PiFM of Norway spruce wood cell wall



TEM Model



cellulose
elementary fibril

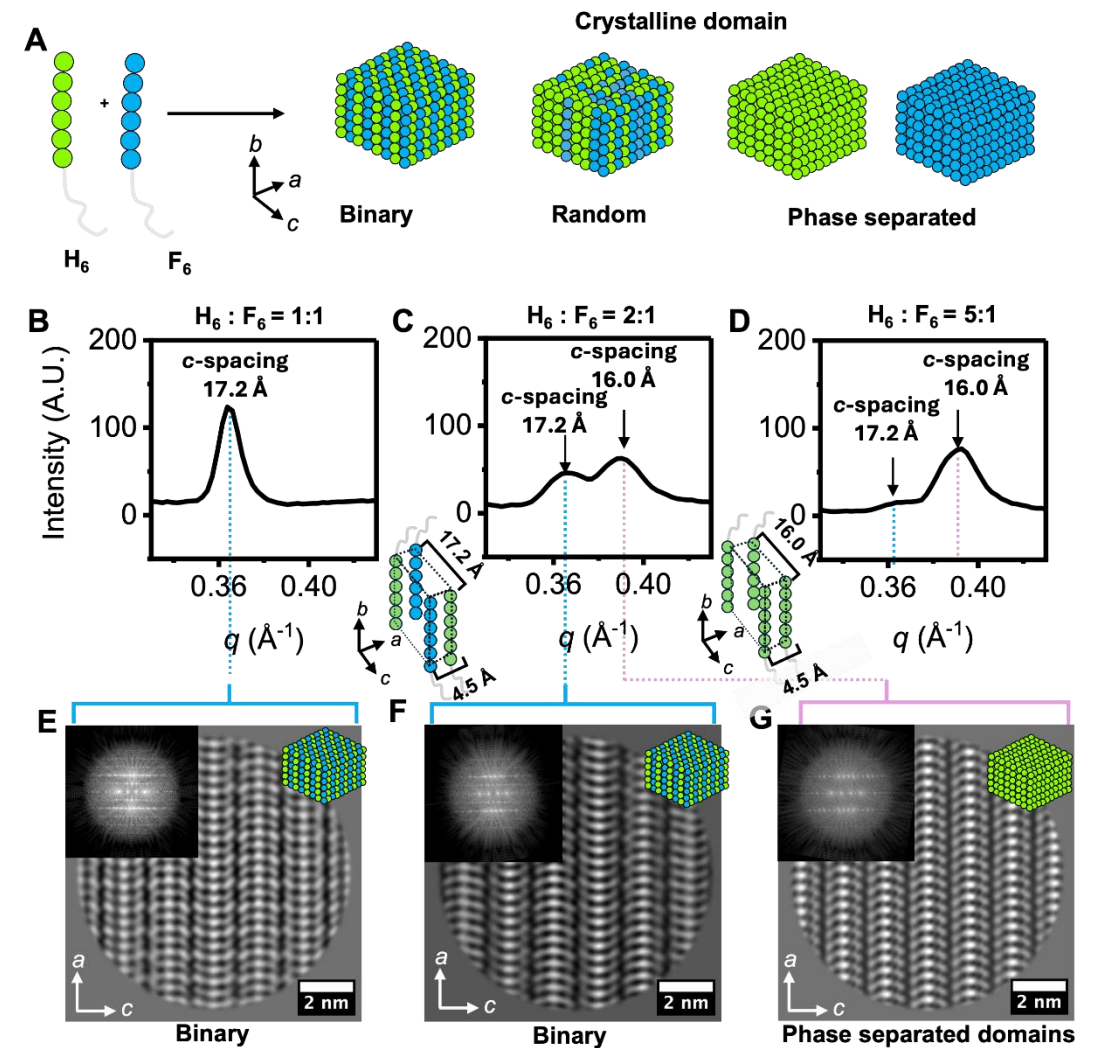
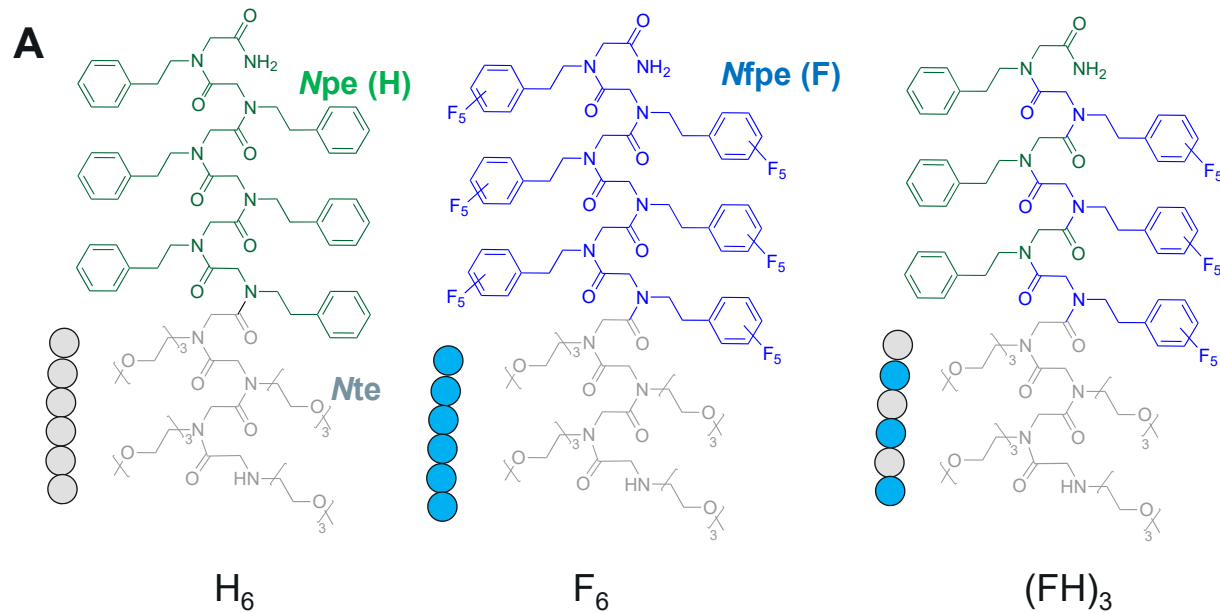
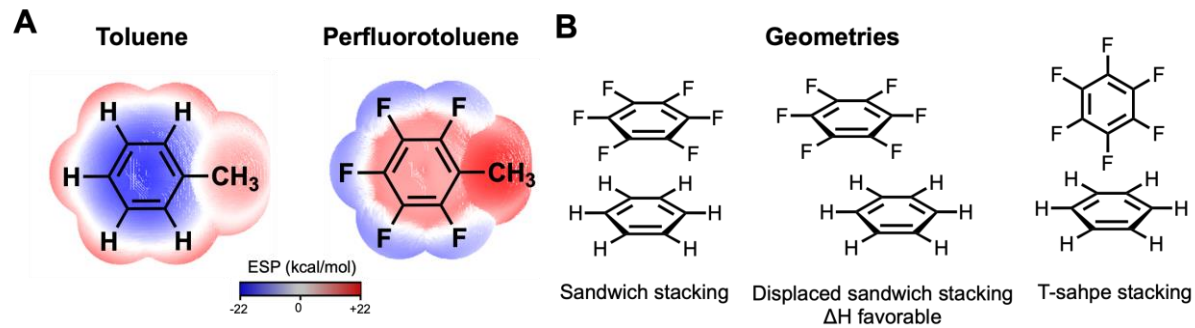
Sub-5 nm spatial resolution!



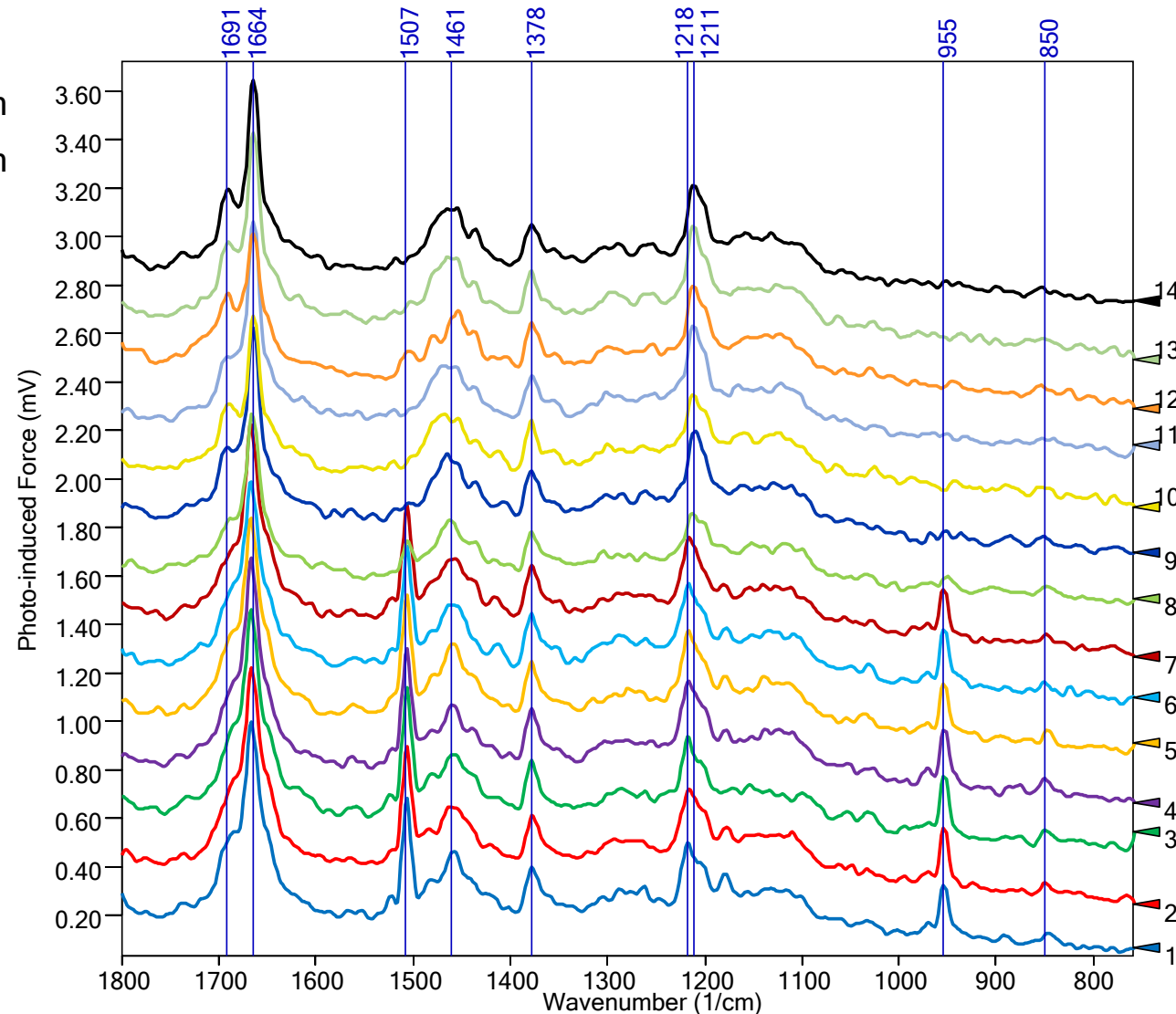
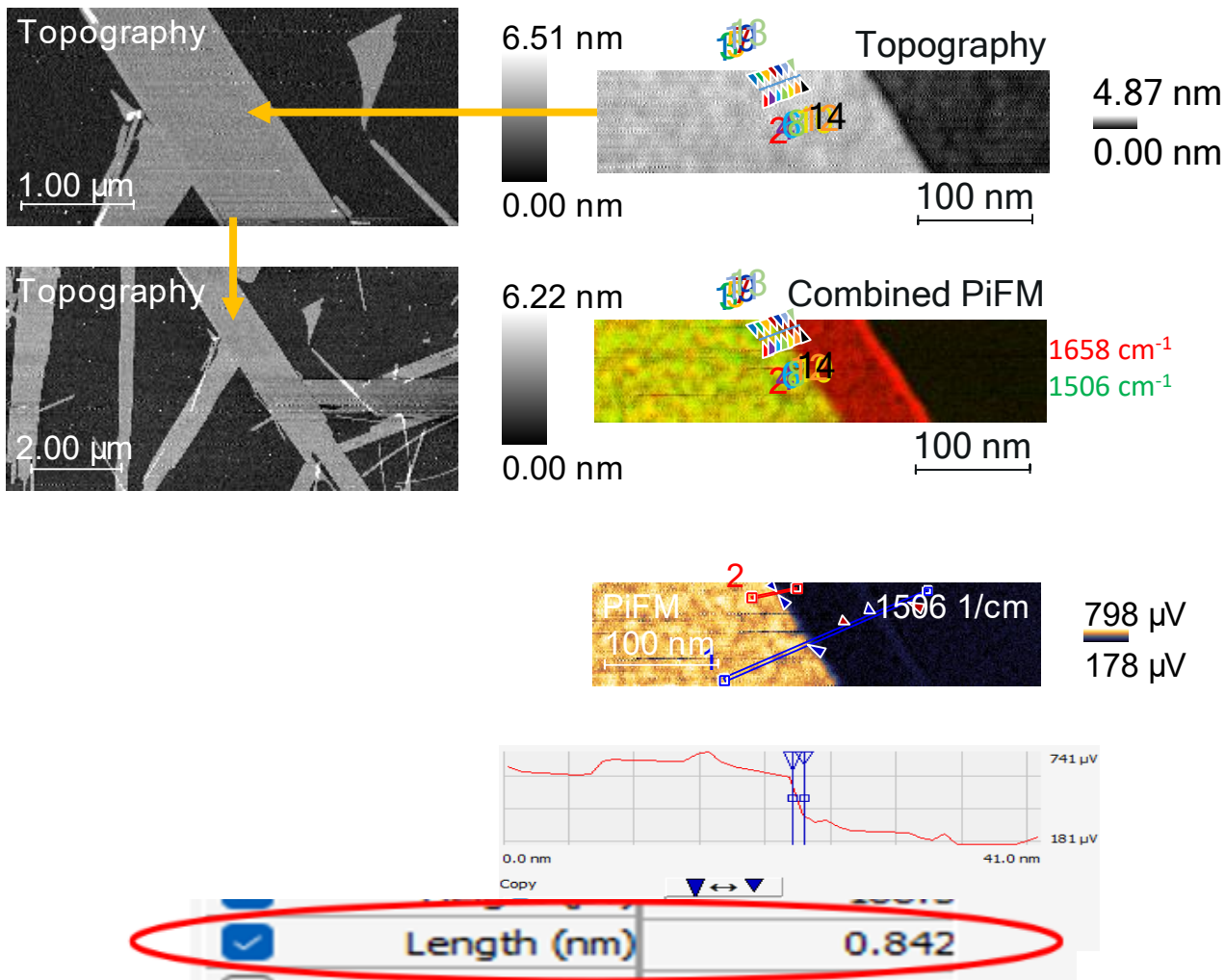


Sub-5 nm Spatial Resolution

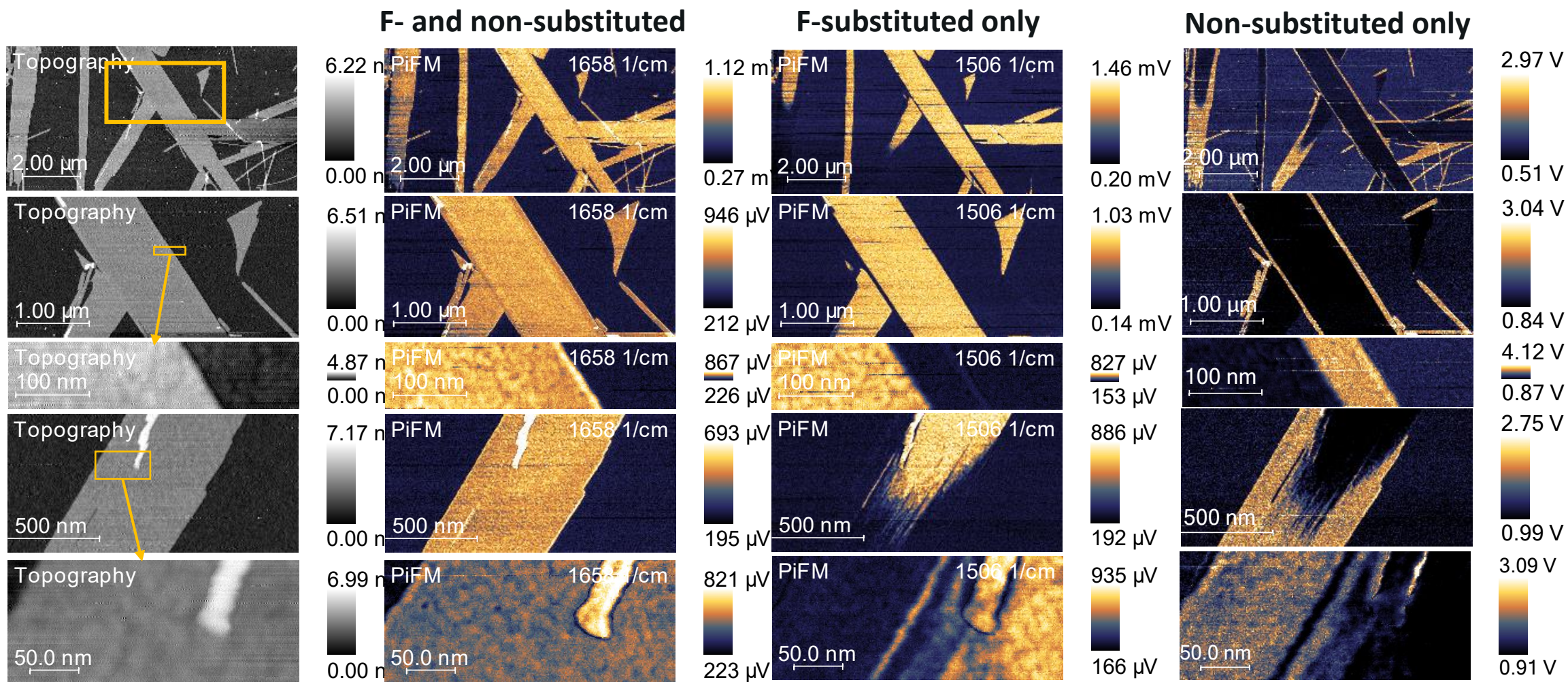
Perfluorophenyl-phenyl interactions in nanosheets



3:1 (Non-substituted:F-substituted derivative)

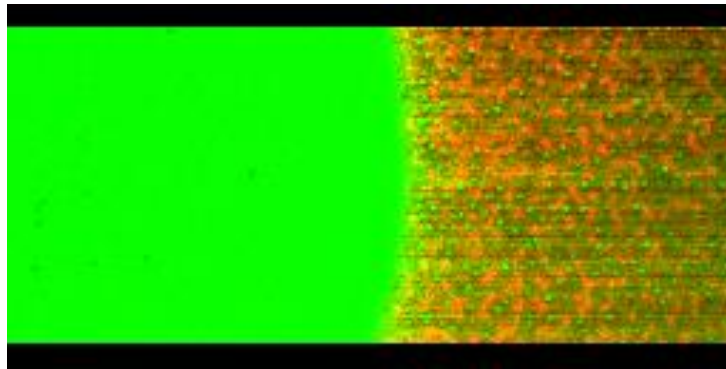
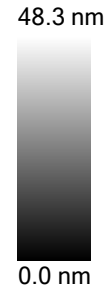
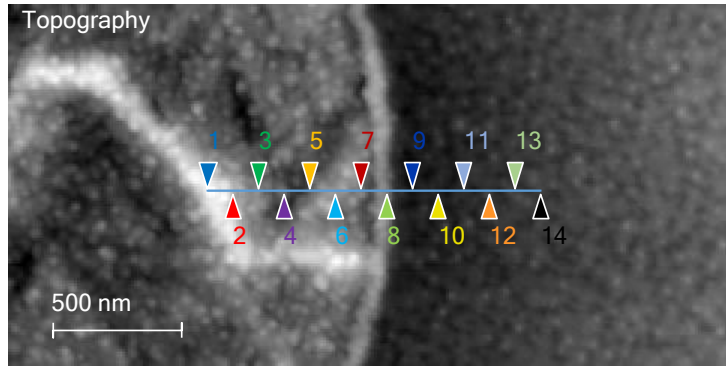


3:1 (Non-substituted:F-substituted derivative)

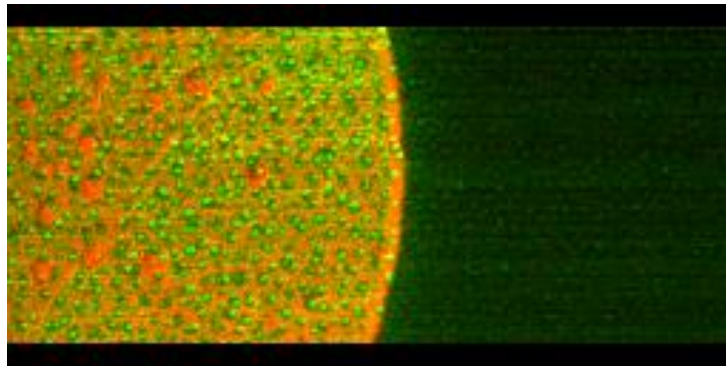


Monitoring Post Glue-clean Wafer

The selection of the wavenumbers for PiFM images are based on PiF-IR spectra acquired on the samples. The triangles show the location of PiF-IR acquired on this sample. The spectra are withheld due to NDA.



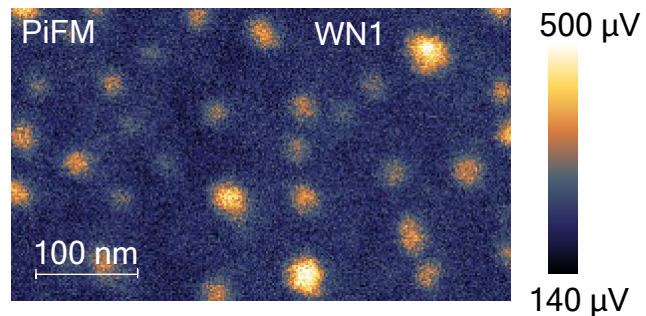
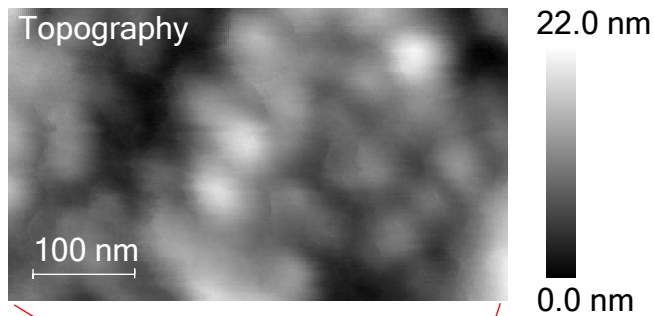
Highlights glue residue at WN1 (green) in the oxide region. The display is adjusted to show the oxide region. Due to the enhanced field enhancement on Cu region, it appears much brighter even at WN1.



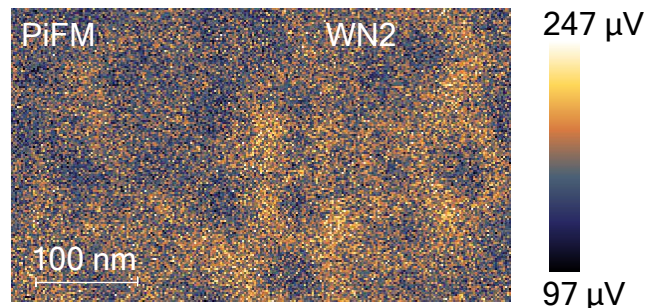
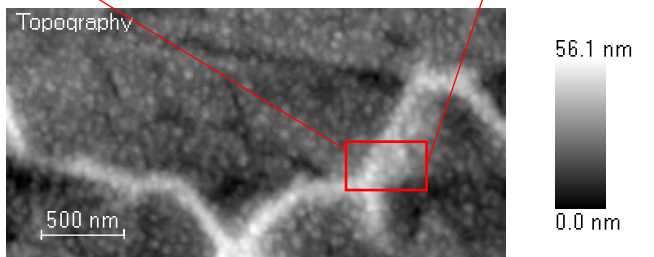
Highlights glue residue at WN1 (green) in the Cu pad region



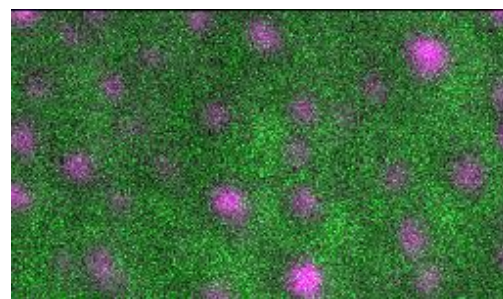
Zoomed-in Cu Pad Region



PiFM image at WN1 highlights the glue that remains even after the cleaning process.



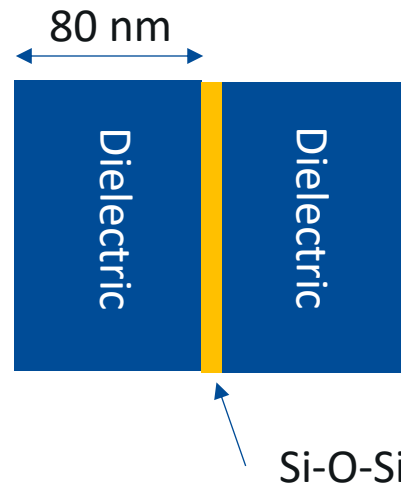
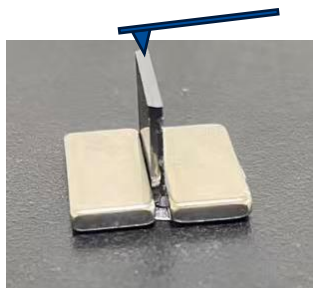
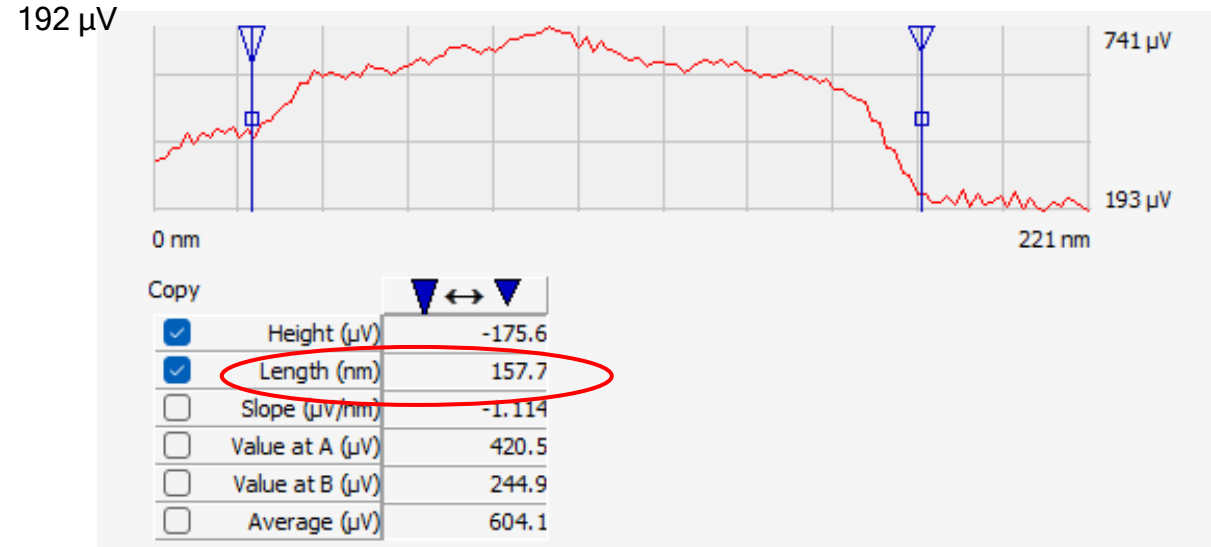
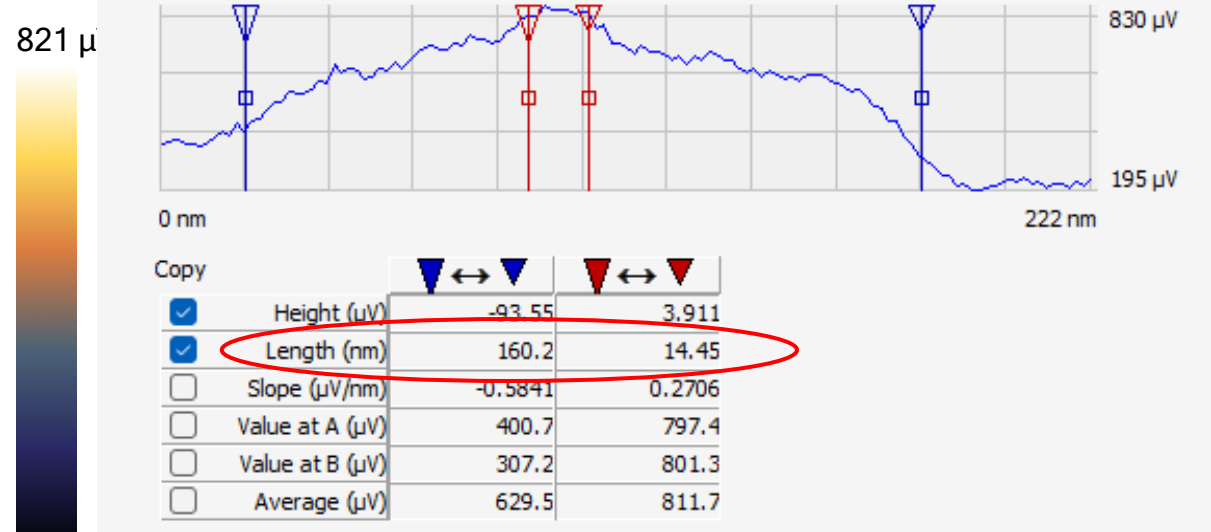
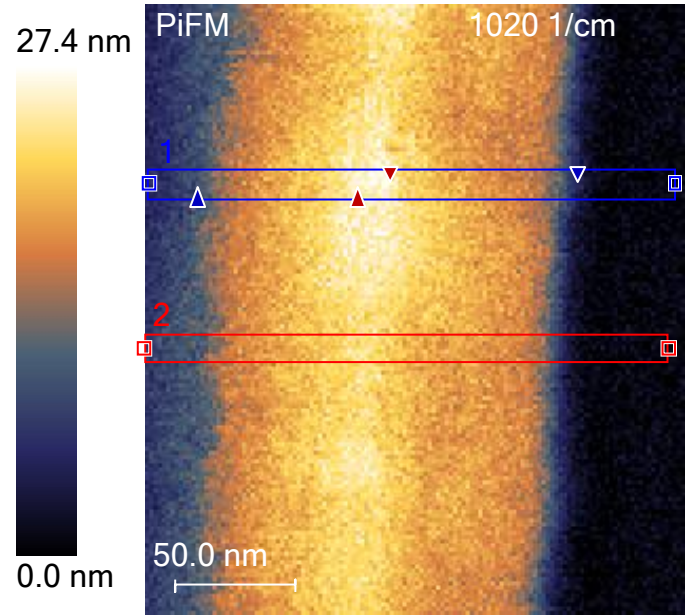
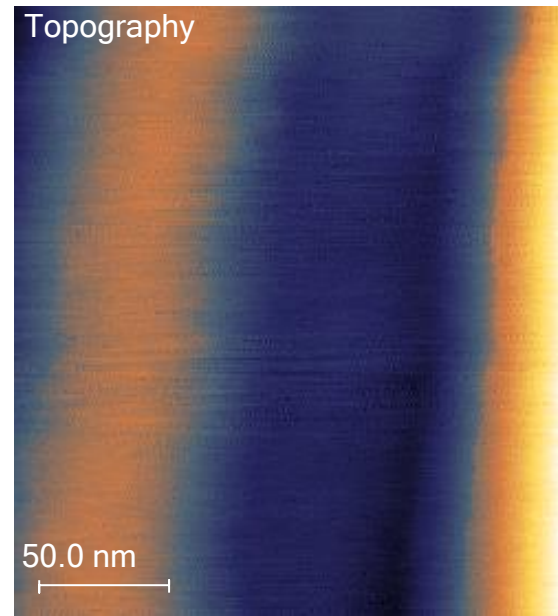
PiFM image at WN2 highlights the Cu^{1+} based compounds (includes Cu_2O and Cu-organic) on the copper pad.



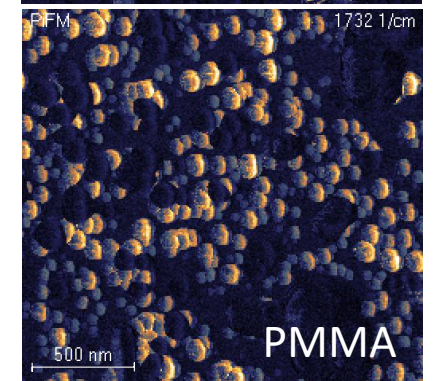
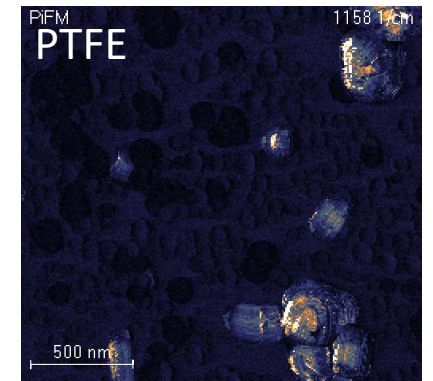
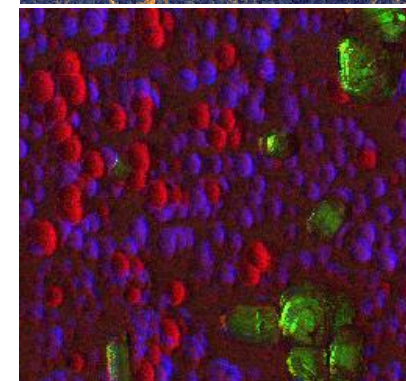
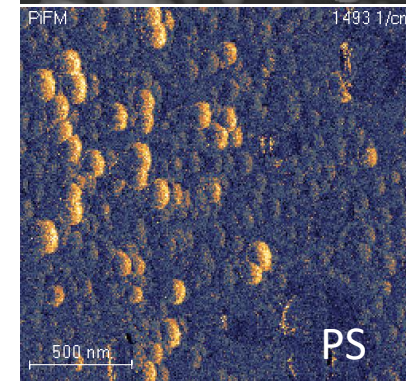
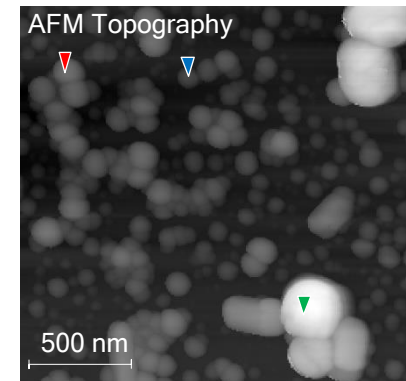
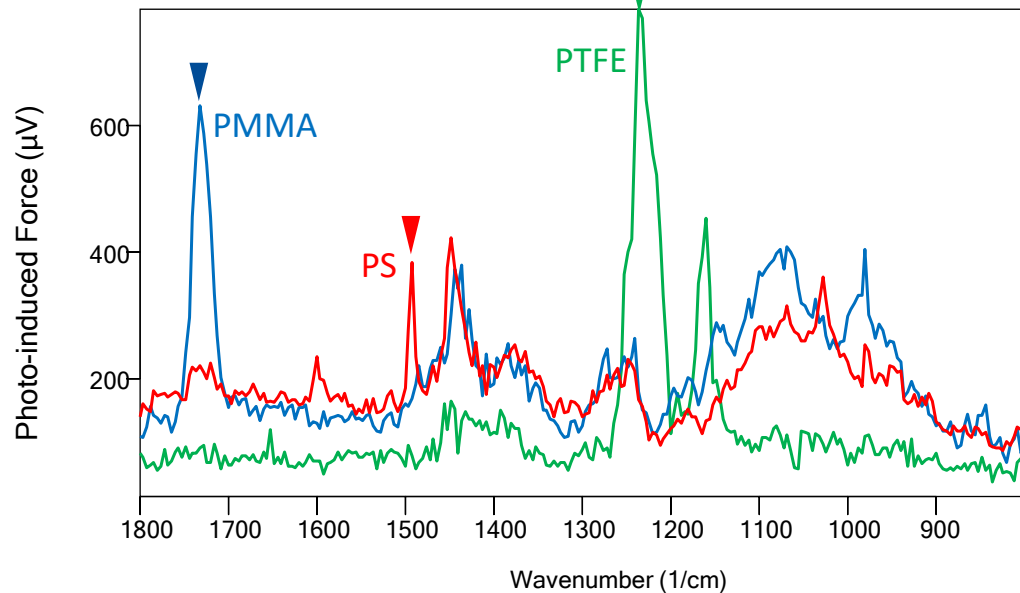
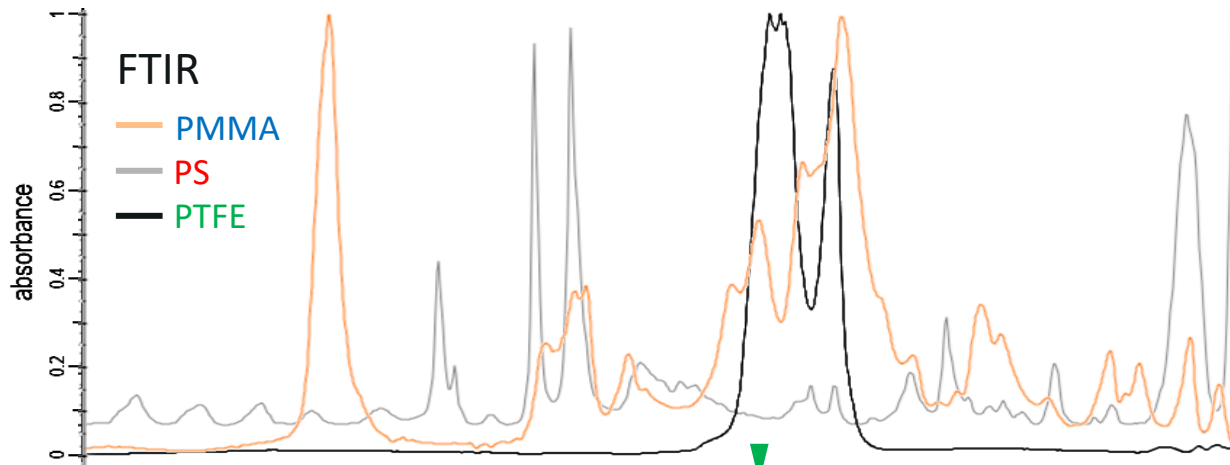
Combined PiFM images show the glue residue (purple) on top of the copper pad (green).



Monitoring Si-O-Si Bonding in Hydrogen Bonded Dielectric Layers



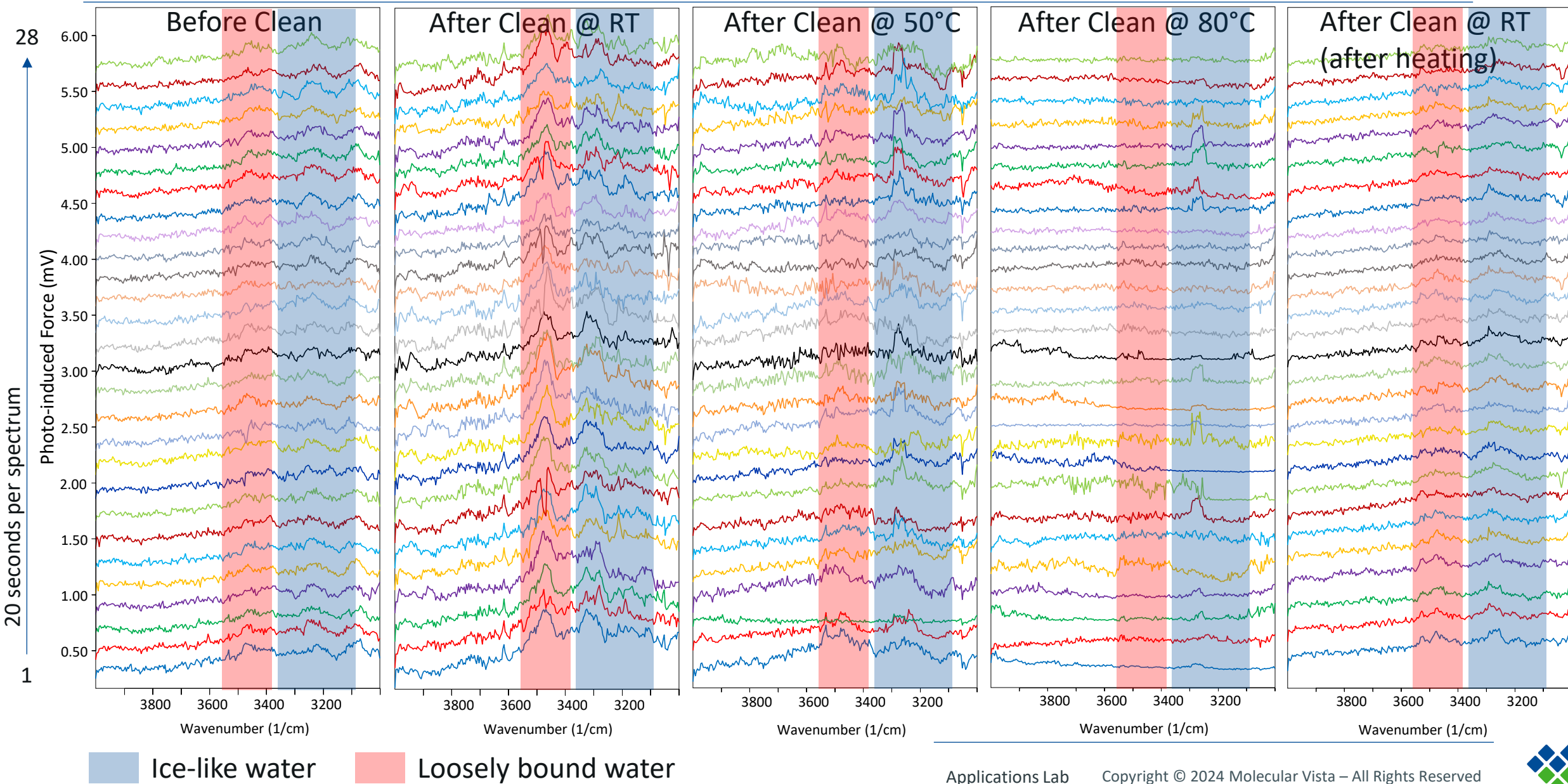
Chemical Analysis of Sub-100 nm Particles



- PMMA (1732 cm^{-1}) \sim 40 nm
- PS (1493 cm^{-1}) \sim 70 nm
- PTFE (1158 cm^{-1}) \sim 190 nm

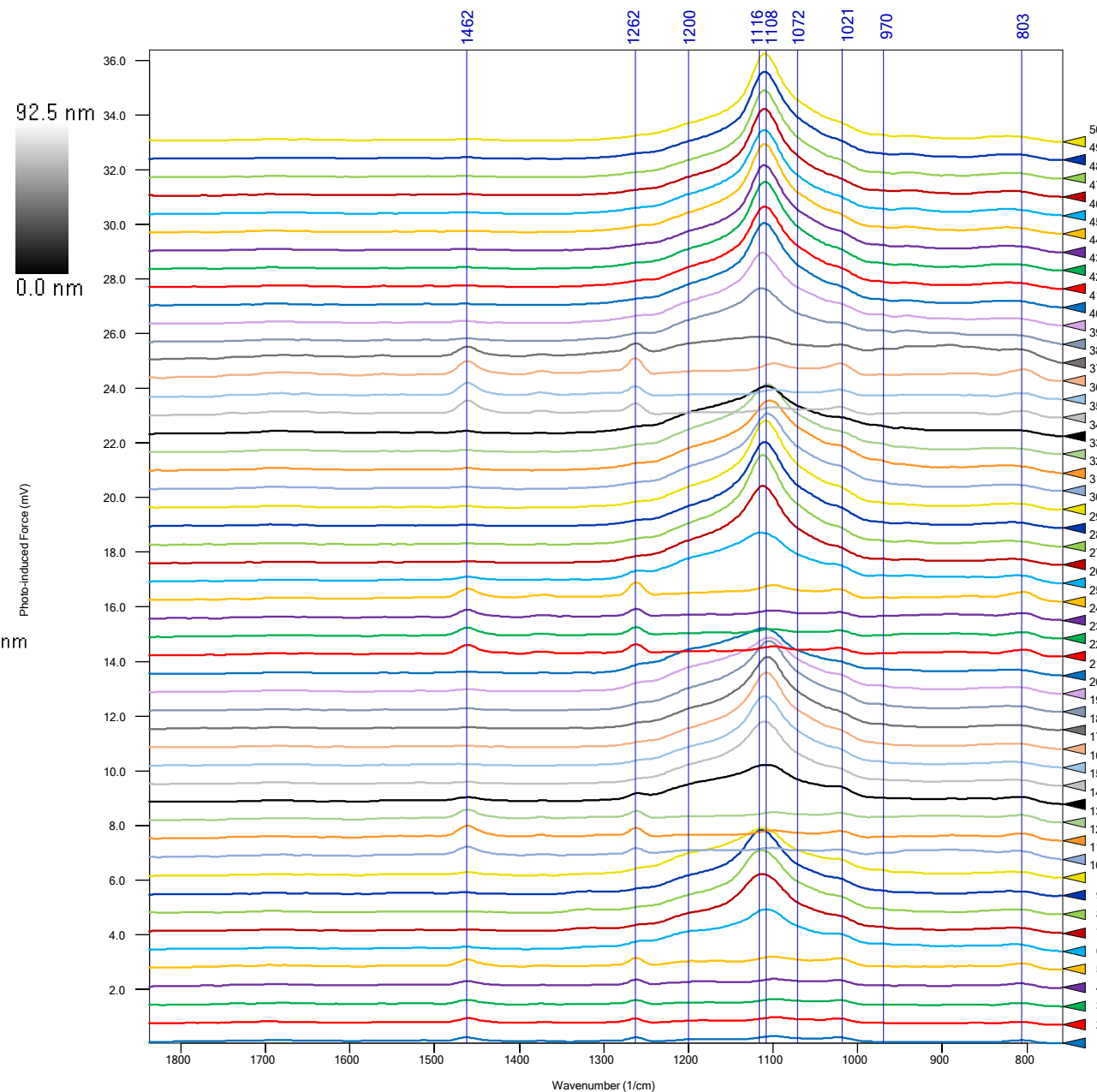
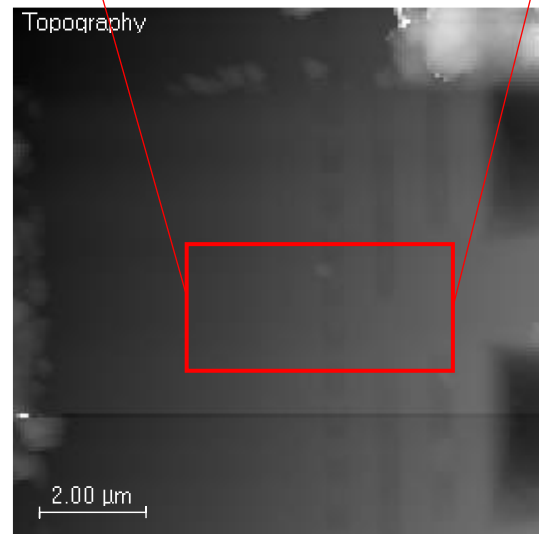
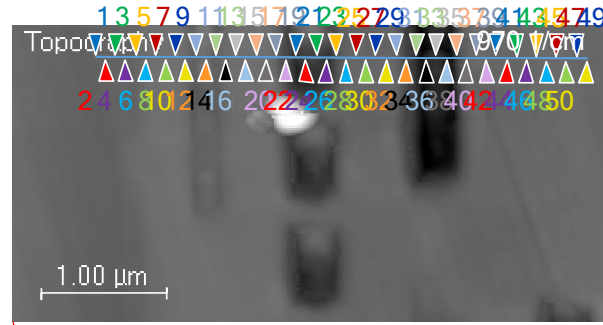


Characterization of -OH Bonds on Clean SiO₂ Surfaces



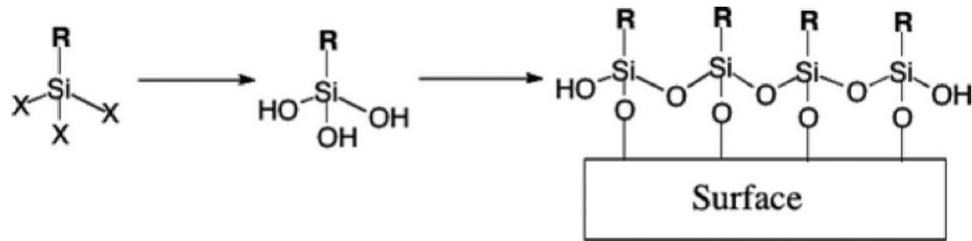
Cross-section Analysis

- The PDMS contamination (1262, 1108, 1021 and 803 cm^{-1}) and hydrocarbon contaminants (1462 cm^{-1}) were found across the sample surface. The PDMS might be from the container of the sample.
- The Si between the metal lines show strong peak around 1116 cm^{-1} .
- There are some variations on spectra around 1200, 1072, and 970 cm^{-1} .

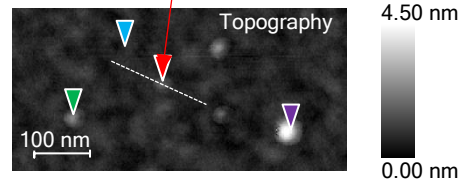
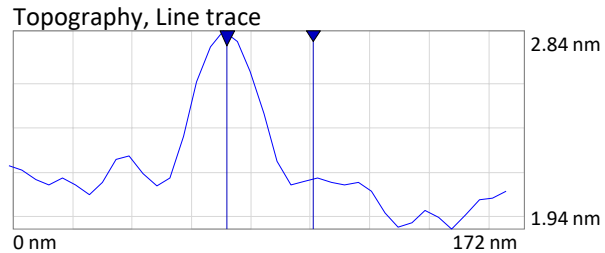


Failed Aminosilane Functionalization

Ideal functionalization should result in a monolayer



Only ~ 0.65 nm tall!

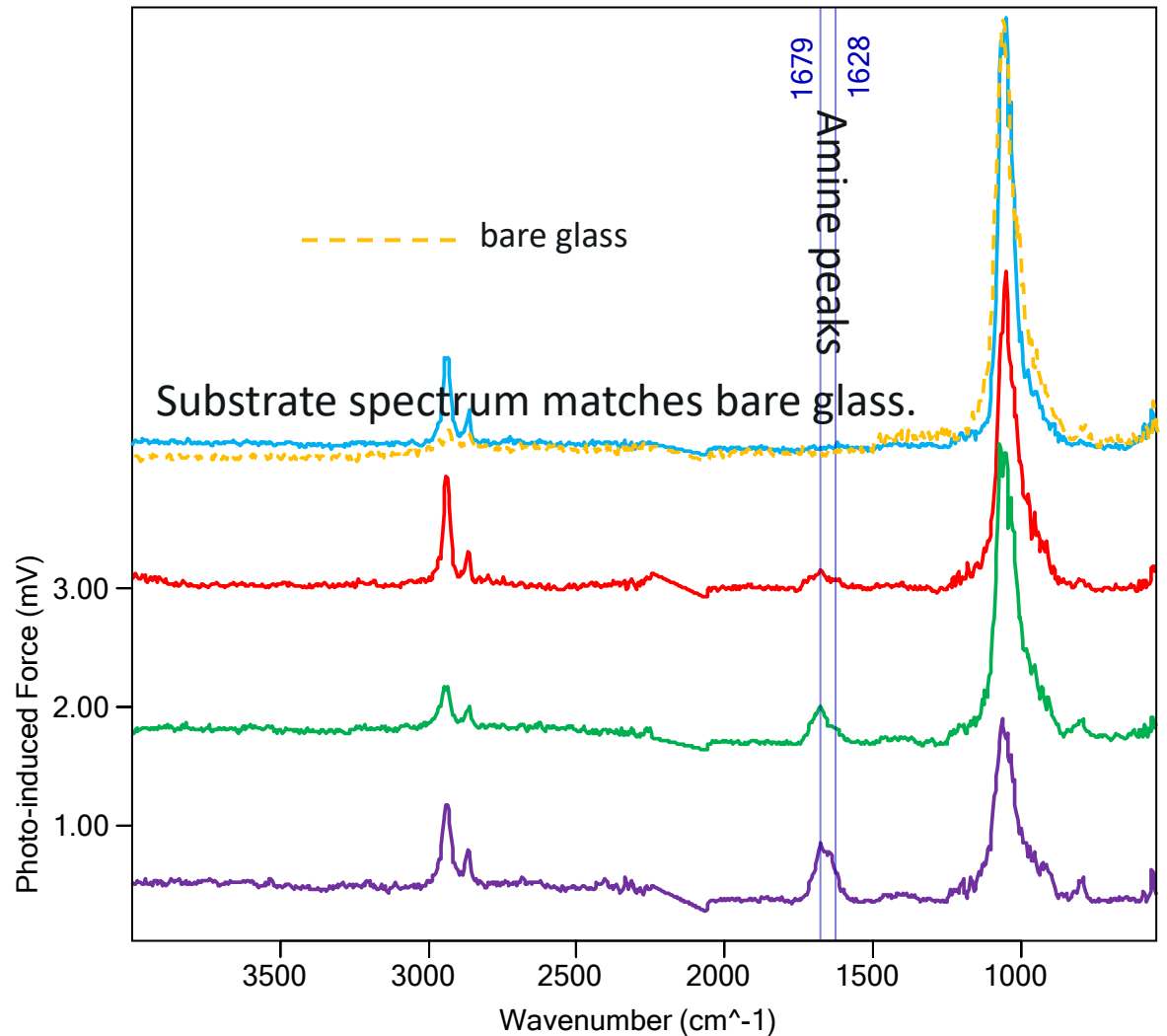


Shows aggregates.

Only aggregates show amine peaks.



Aminosilane molecules are mapped.





PiFM for Surface Chemistry Analysis

Role of Cu Oxidation in Low T Cu-Cu Hybrid Bonding

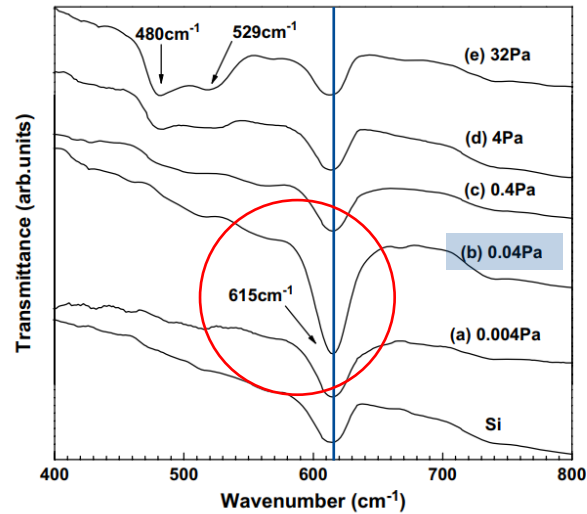


Fig. 3. The FTIR spectra of copper oxide films prepared at 500 °C under oxygen pressure of (a) 0.004 Pa, (b) 0.04 Pa, (c) 0.4 Pa, (d) 4 Pa and (e) 32 Pa.

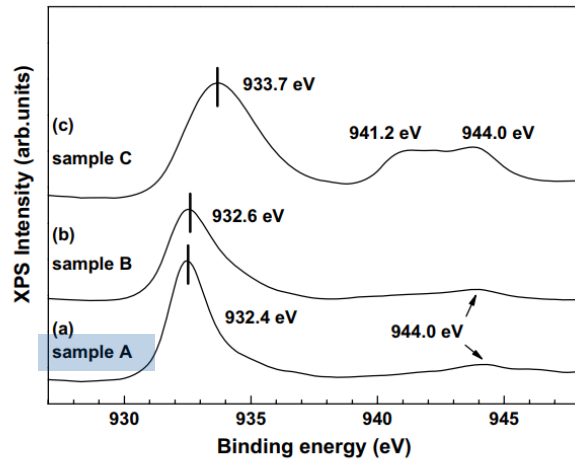


Fig. 4. XPS $\text{Cu}2p_{3/2}$ core-level spectra of samples A, B and C.

surface of the films, three typical samples deposited under 0.04 Pa (sample A), 0.4 Pa (sample B), 32 Pa (sample C) were determined by

Impact of Plasma Activation on Copper Surface Layer for Low Temperature Hybrid Bonding

Christopher Netzband, Dylan Burns, Kandabara Tapily, Son Ilseok, Cory Wajda
TEL Technology Center, America, LLC
Albany, NY, United States

Table 1: Diffusion lengths of Cu during a 30min anneal

Species	Diffusion Length of Cu Through Different Species at Varying Temperatures (nm)				
	100°C	150°C	200°C	250°C	300°C
Cu ₂ O	0.17	1.5	8.45	34.16	108.38
CuN	0.0005	0.01	0.15	1.14	6.13
CuO	0.0003	0.006	0.05	0.33	1.48

How to monitor for Cu⁺¹ (Cu_2O) with PiFM?

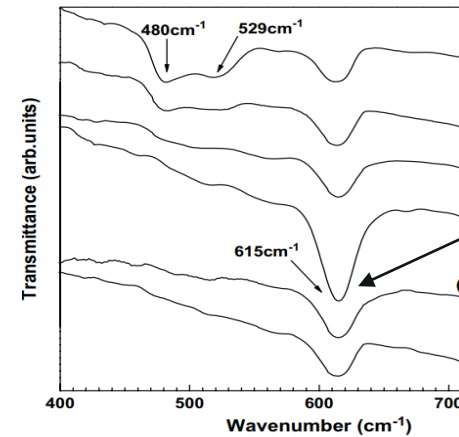
Use the IR peak at $\sim 615 \text{ cm}^{-1}$!



Mapping Cu Oxide State for Hybrid Bonding

Table 1: Diffusion lengths of Cu during a 30min anneal

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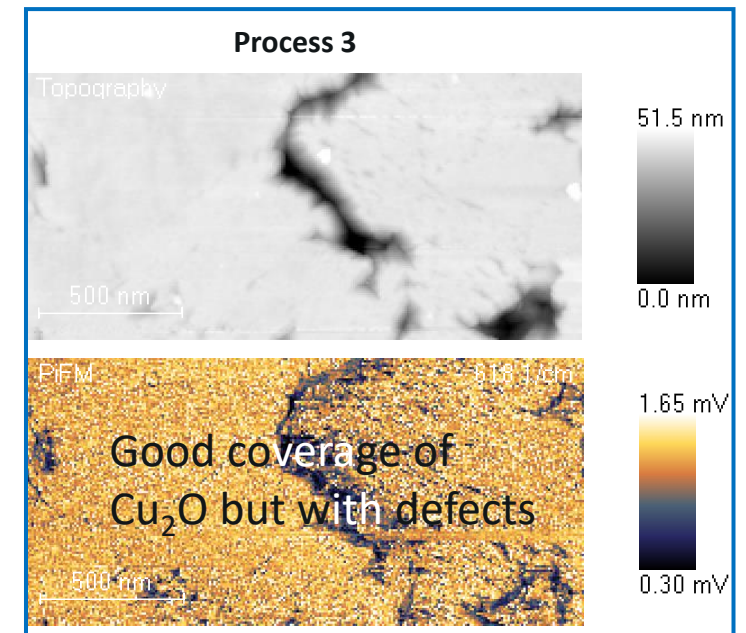
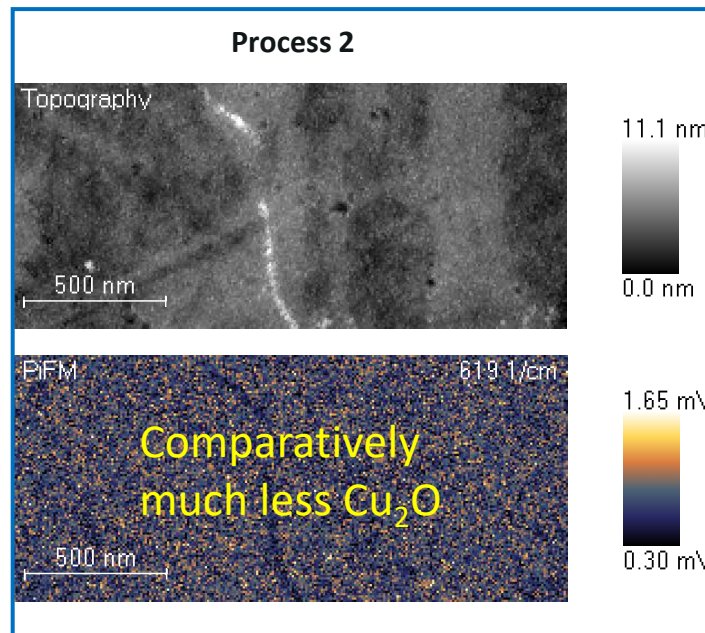
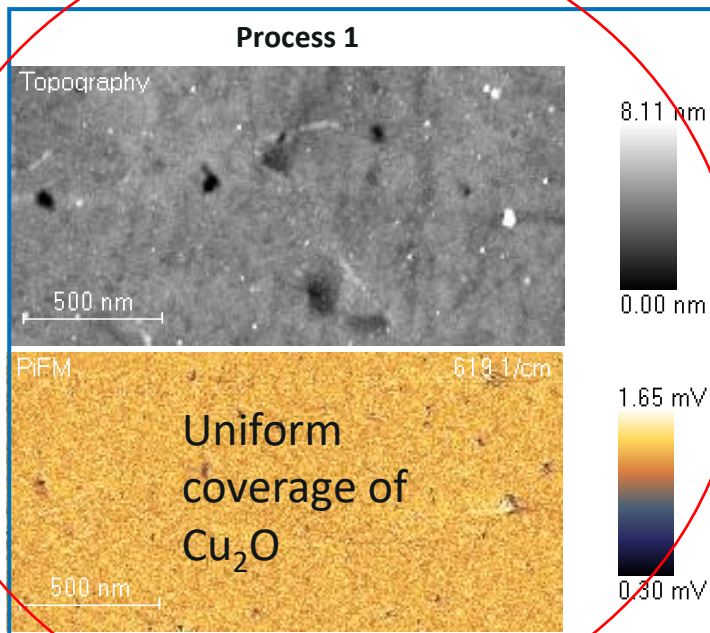


Cu₂O characterized by a peak at ~ 615 cm⁻¹.

Cu₂O better than CuO for low-T Cu-Cu Hybrid Bonding

2023 IEEE 73rd Electronic Components and Technology Conference (ECTC), p351

Mapping the amount of Cu⁺¹ (Cu₂O) state with PiFM at 619 cm⁻¹.



BEST!

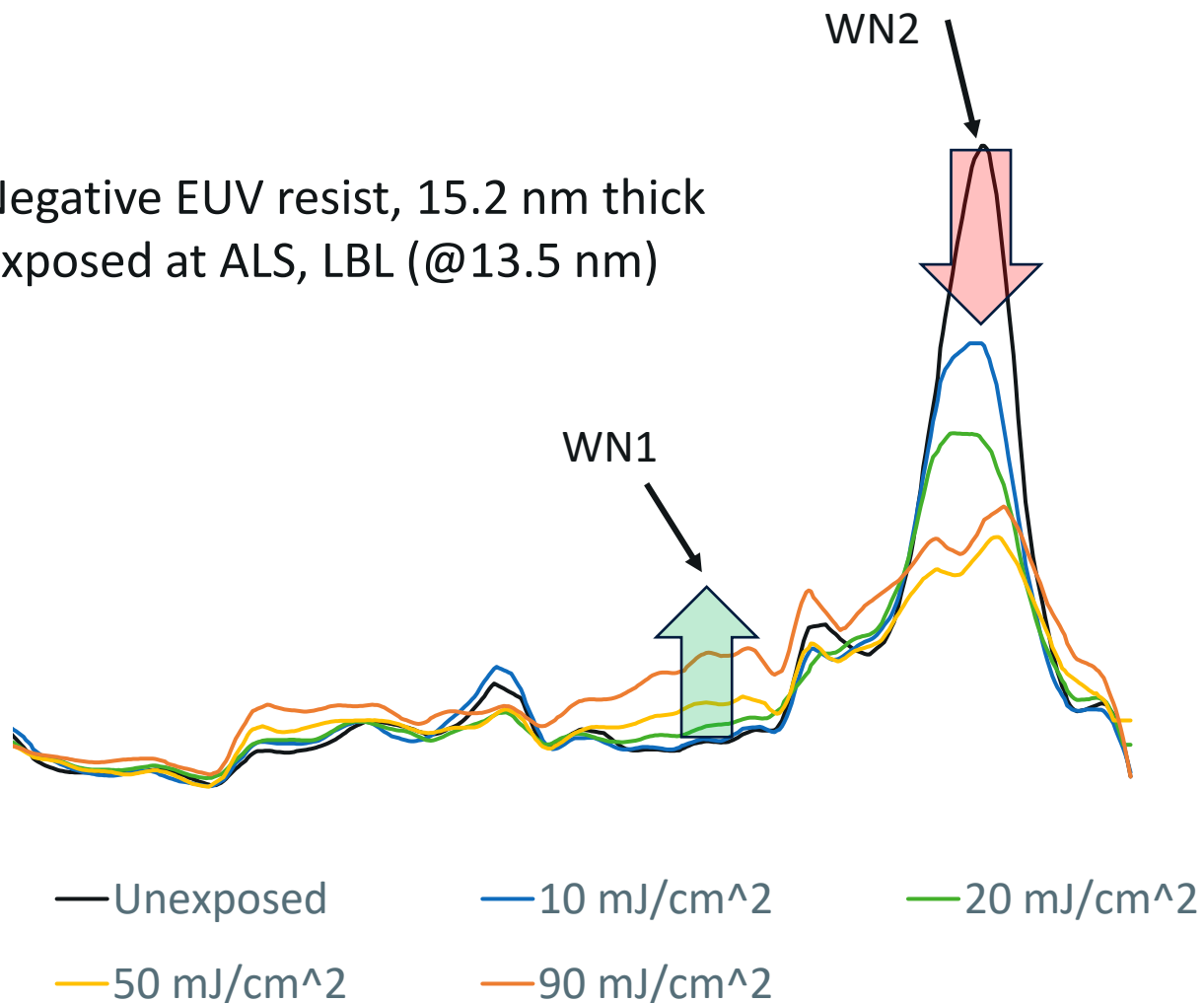




PiFM for EUV Lithography

Changes to IR Peaks upon EUV Exposure

- Negative EUV resist, 15.2 nm thick
- Exposed at ALS, LBL (@13.5 nm)



Nano IR spectra at different dose.

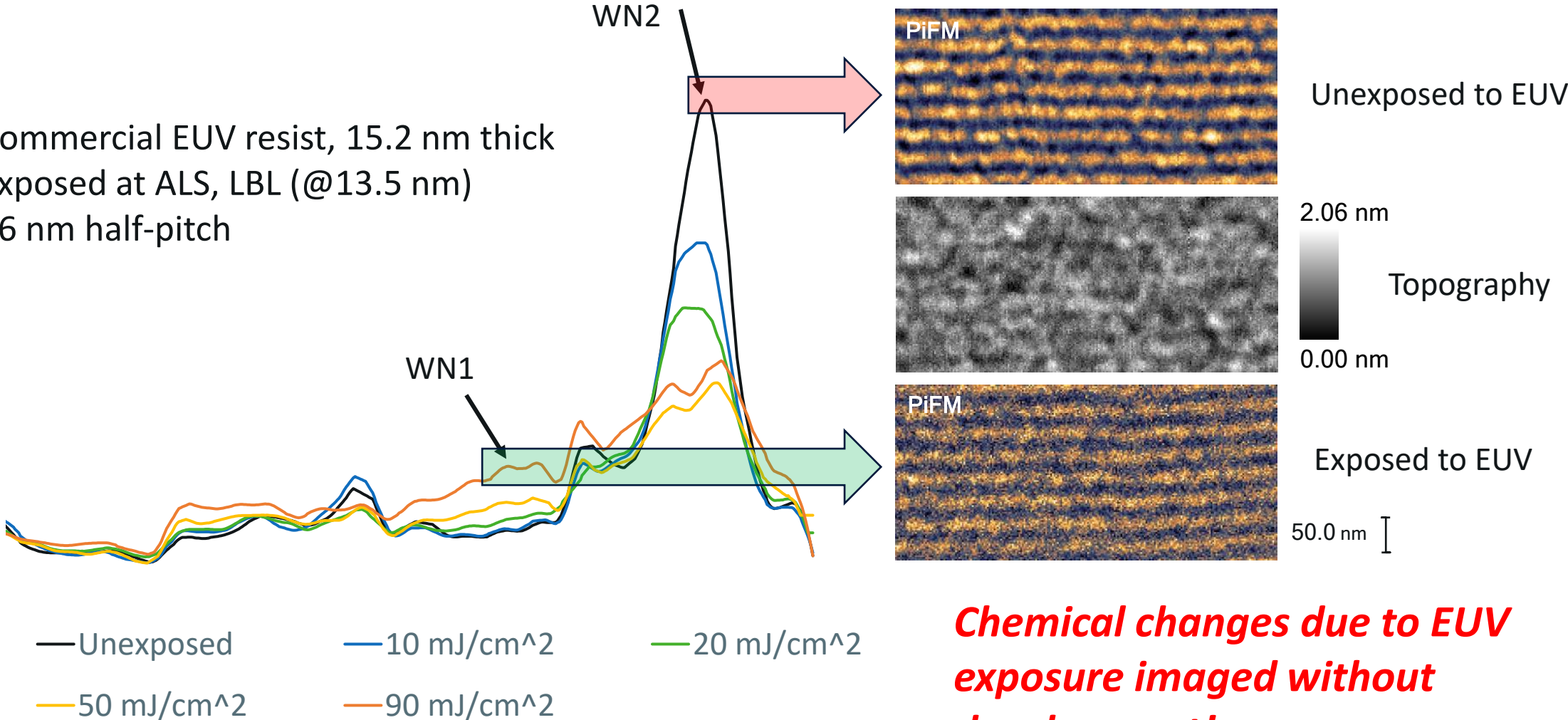
Nano IR signal changes upon EUV exposure.

PiFM images @ WN2 and WN1 will provide latent (undeveloped) images based on *chemical change*.



Latent Images due to Chemical Changes upon EUV Exposure

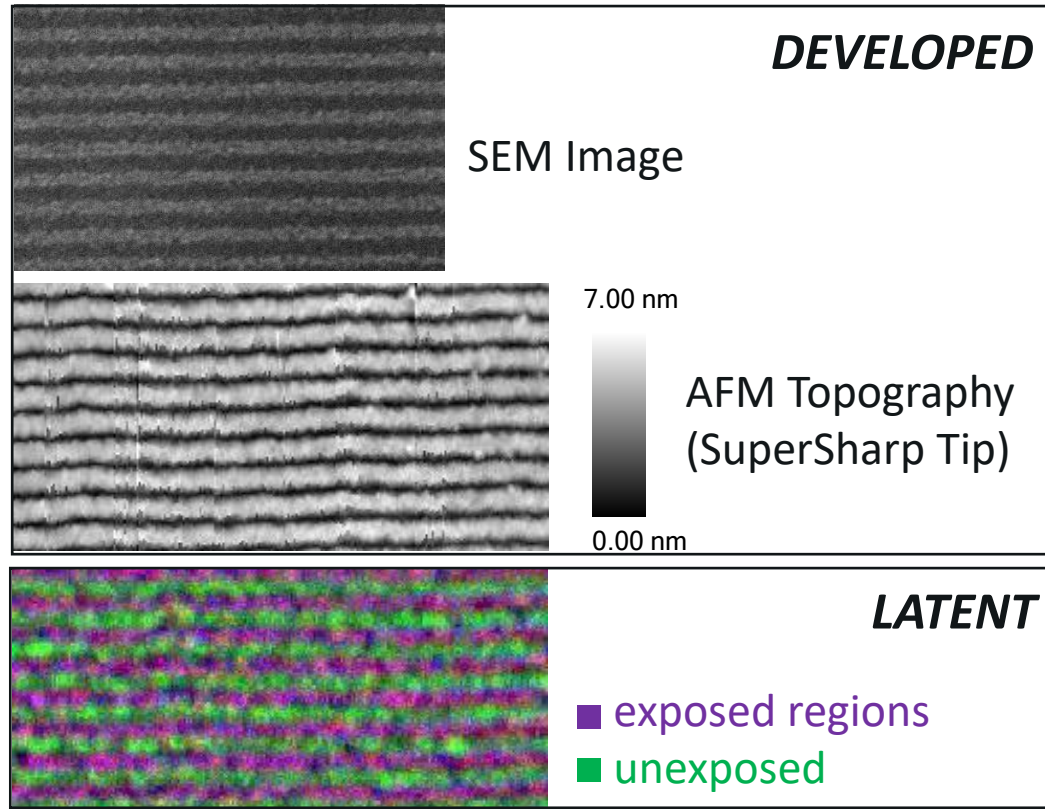
- Commercial EUV resist, 15.2 nm thick
- Exposed at ALS, LBL (@13.5 nm)
- 16 nm half-pitch



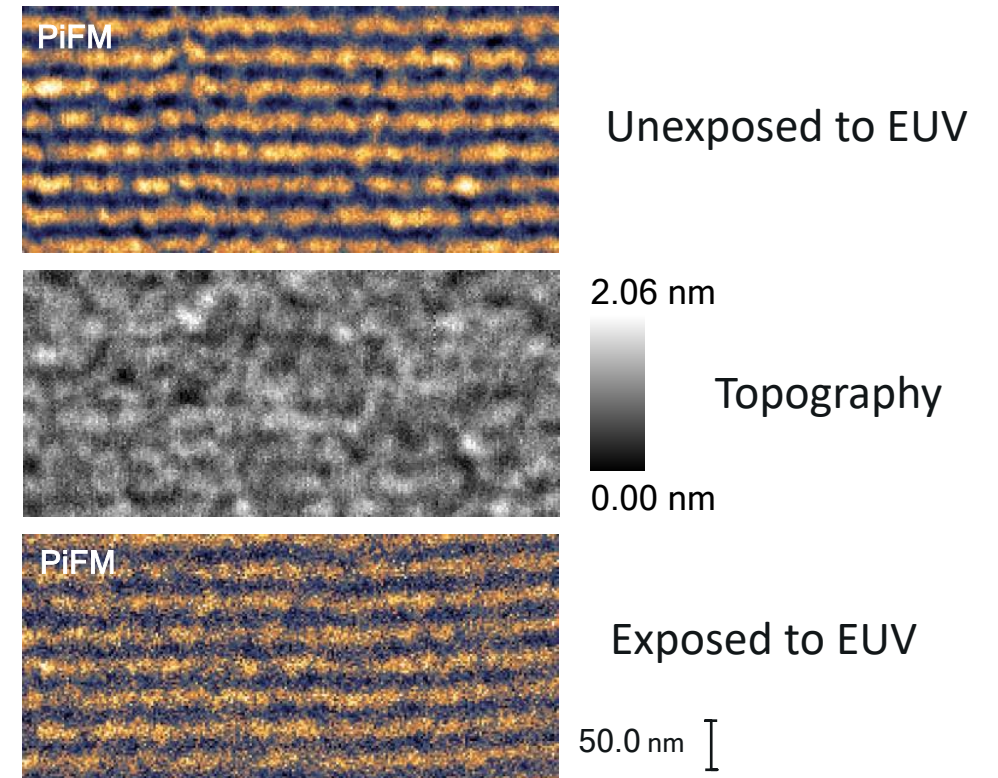
Chemical changes due to EUV exposure imaged without development!



Comparing Latent & Developed Images



Developed pattern compared to the latent image.

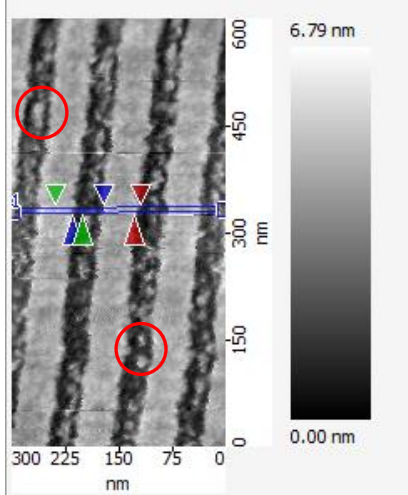


Chemical changes due to EUV exposure imaged without development!



Residues in Developed Pattern Predicted in Latent Images

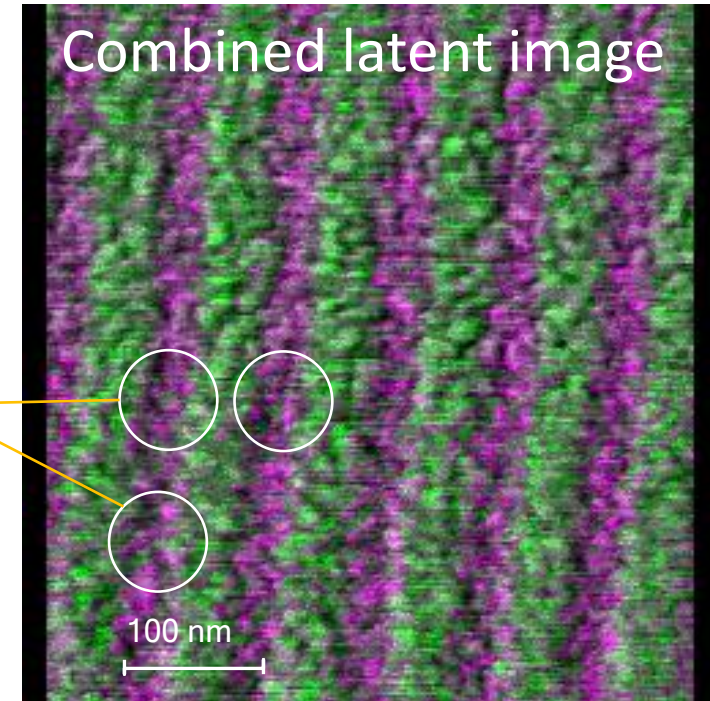
Developed pattern



Negative resist → exposed regions remain.
Visible residues.

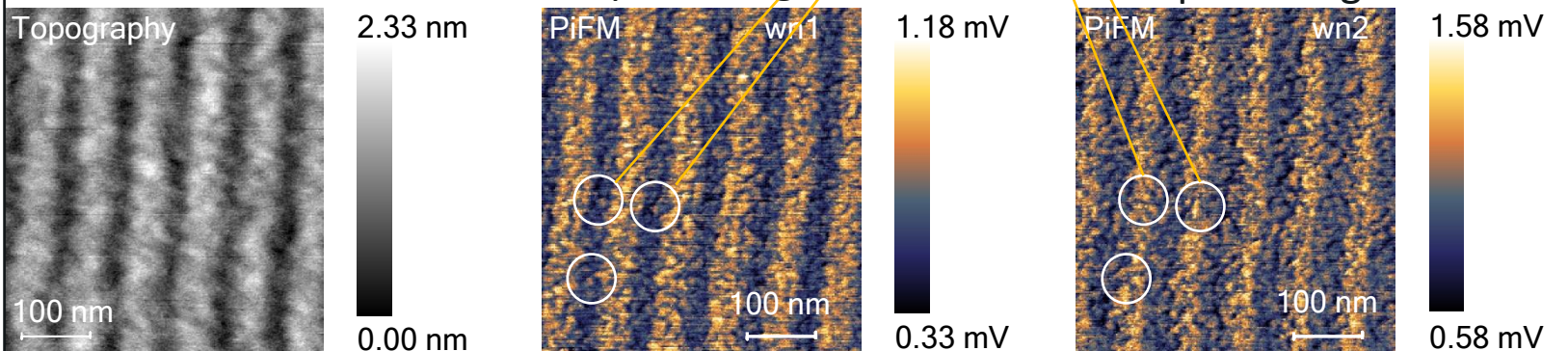
Some unexposed regions look as if
chemically exposed → lead to residue?

Combined latent image



Exposed Unexposed

Latent Images



PiFM for EUV Lithography

- Latent imaging – study impact of many parameters on LER and LWR upon EUV exposure without developing but purely based on chemical signature
 - Chemical composition
 - Underlayer
 - Thickness
 - Dose
 - Post exposure processing

